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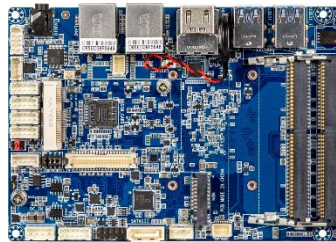


 DISPLAY
TECHNOLOGY



Manual

GIGAIPC



QBiP-6210A / QBiP-6412A

3.5" SubCompact SBC with Intel® Celeron® N6210 / J6412 Processor, Dual Channel DDR4 memory, 4 x COM, 1 x SATA 6Gb/s, 4 x USB 3.2 Gen 1, 2 x USB 2.0

QBiP-x6413EAT / QBiP-x6413EA

3.5" SubCompact (Wide Temperature) SBC with Intel® Atom® x6413E Processor, Dual Channel DDR4 memory, 4 x COM, 1 x SATA 6Gb/s, 4 x USB 3.2 Gen 1, 2 x USB 2.0, Temp -40° C to 85°C

QBiP-6412A/ QBiP-6210A

3.5" SBC Boards
User's Manual 1st Ed

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All other product names or trademarks are properties of their respective owners.

Packing List

Before setting up your product, please make sure the following items have been shipped:

Item	Quantity
QBiP-6412A/ QBiP-6210A	1
SATA power cable	1

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the GIGAIPC.com for the latest version of this document.

Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

1. All cautions and warnings on the device should be noted.
2. Make sure the power source matches the power rating of the device.
3. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
4. Always completely disconnect the power before working on the system's hardware.
5. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
6. If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
7. Always disconnect this device from any AC supply before cleaning.
8. While cleaning, use a damp cloth instead of liquid or spray detergents.
9. Make sure the device is installed near a power outlet and is easily accessible.
10. Keep this device away from humidity.
11. Place the device on a solid surface during installation to prevent falls
12. Do not cover the openings on the device to ensure optimal heat

dissipation.

13. Watch out for high temperatures when the system is running.
14. Do not touch the heat sink or heat spreader when the system is running
15. Never pour any liquid into the openings. This could cause fire or electric shock.
16. As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and contain all electronic components in any static-shielded containers.
17. If any of the following situations arises, please the contact our service personnel:
 - i. Damaged power cord or plug
 - ii. Liquid intrusion to the device
 - iii. Exposure to moisture
 - iv. Device is not working as expected or in a manner as described in this manual
 - v. The device is dropped or damaged
 - vi. Any obvious signs of damage displayed on the device

18. DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

FCC Statement

Warning!



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

China RoHS Requirements (CN)

产品中有毒有害物质或元素名称及含量

GIGAIPC Main Board/ Daughter Board/ Backplane

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯 醚 (PBDE)
印刷电路板 及其电子组件	○	○	○	○	○	○
外部信号 连接器及线材	○	○	○	○	○	○

○: 表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。

X: 表示该有毒有害物质至少在该部件的某一均质材料中的含量超出

SJ/T 11363-2006 标准规定的限量要求。

备注: 此产品所标示之环保使用期限, 系指在一般正常使用状况下。

China RoHS Requirement (EN)

Poisonous or Hazardous Substances or Elements in Products GIGAIPC Main Board/ Daughter Board/ Backplane

Component	Poisonous or Hazardous Substances or Elements					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)
PCB & Other Components	O	O	O	O	O	O
Wires & Connectors for External Connections	O	O	O	O	O	O

O : The quantity of poisonous or hazardous substances or elements found in each of the component's parts is below the SJ/T 11363-2006-stipulated requirement.
X: The quantity of poisonous or hazardous substances or elements found in at least one of the component's parts is beyond the SJ/T 11363-2006-stipulated requirement.
Note: The Environment Friendly Use Period as labeled on this product is applicable under normal usage only

Table Contents

3.5” SBC Boards	1
User’s Manual 1st Ed	
Copyright Notice	2
Acknowledgement	3
Packing List.....	4
About this Document	5
Safety Precautions	6
FCC Statement.....	8
China RoHS Requirements (CN).....	9
China RoHS Requirement (EN)	10
Chapter 1 - Product Specifications	14
1.1 Specifications- QBiP-6412A/ QBiP-6210A	16
Chapter 2 – Hardware Information	18
2.1 Jumpers and Connectors	19
2.2.1 FAN (FAN connector)	22
2.2.2 DC_IN (DC IN 1x4pin power connector)	23
2.2.3 AT_CN (AT/ATX mode select jumper).....	24
2.2.4 BKL_CN (Backlight Control connector)	25
2.2.5 JCOM1 (RI# pin RI#/5V/12V Select jumper for COM1 Port)	26
2.2.6 COM1, COM2, COM3, COM4 (Serial port header)	27
2.2.7 SPKR (Speaker out connector)	28
2.2.8 FP_AUDIO (Front panel audio header).....	29

2.2.9	SODIMMA, SODIMMB (DDR4 SO-DIMM sockets)	30
2.2.10	SYS_PANEL (Front panel header)	31
2.2.11	M2M (M.2 Slot, M-Key, NGFF 2280)	32
2.2.12	SATAPW (SATA power connector)	33
2.2.13	SATAIII (SATA 6Gb/s Connector)	34
2.2.14	FUSB20 (USB 2.0 header)	35
2.2.15	GPIO_CNT (General Purpose input/output header) ...	36
2.2.16	LVDS (LVDS connector).....	37
2.2.17	LSW (LVDS resolution jumper)	38
2.2.18	SIM_CARD (3G/4G SIM Slot)	39
2.2.19	MPCIE (Mini PCIe slot).....	40
2.2.20	BUZZER (Buzzer header).....	41
2.2.21	BATTERY	42
2.2.22	LAN1, LAN2 (LAN connector).....	43
2.2.23	HDMI (HDMI connector)	44
2.2.24	USB31_1, USB31_2 (USB 3.2 Gen 1 connector).....	45

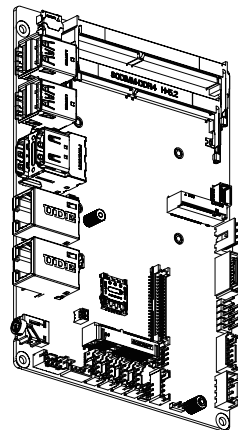
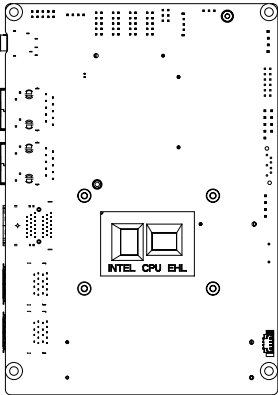
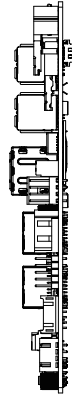
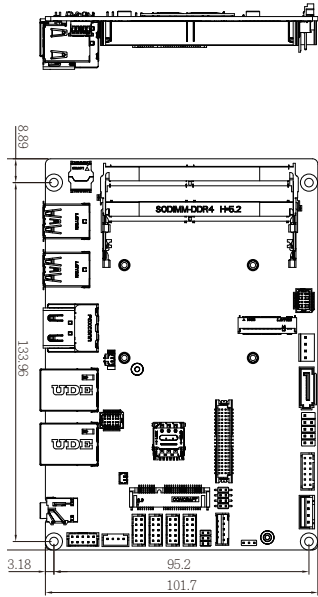
Chapter 3 – BIOS 46

3.1	Introduction	47
3.2	The Main Menu.....	48
3.3	Advanced	49
3.3.1	TPM Configuration.....	50
3.3.2	IT8786 Super IO Configuration	52
3.3.3	Hardware Monitor	53
3.3.4	S5 RTC Wake Settings	54
3.3.5	CPU Configuration	55

3.3.6	SATA Configuration	56
3.3.7	AMI Graphic Output Protocol Policy.....	57
3.3.8	Network Stack Configuration.....	58
3.3.9	NVMe Configuration	59
3.3.10	Offboard SATA Controller Configuration	60
3.3.11	Digital IO Port Configuration	61
3.4	Chipset	62
3.5	Security	63
3.6	Boot.....	66
3.7	Save & Exit	67

Chapter 1

Chapter 1 - Product Specifications QBiP-6412A / QBiP-6210A



1.1 Specifications- QBiP-6412A/ QBiP-6210A

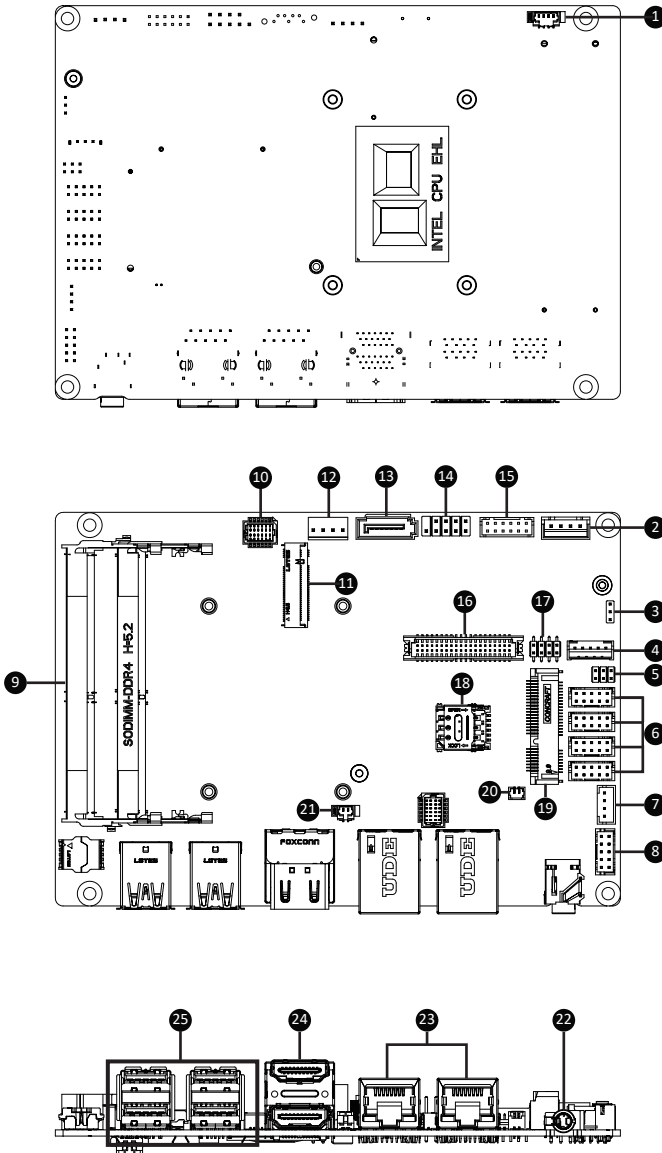
Motherboard	QBiP-6412A	QBiP-6210A
Form Factor	3.5" SBC 146W x 101.7D (mm)	
CPU	Intel® Celeron® J6412 Processor 10nm, 4 cores, 4 threads, up to 2.60 GHz TDP 10W	Intel® Celeron® N6210 Processor 10nm, 2 cores, 2 threads, up to 2.60 GHz TDP 6.5W
Socket	1 x FCBGA1493	
Memory	2 x DDR4 SO-DIMM sockets, Max. Capacity 32 GB Support Dual Channel DDR4 3200 MHz memory modules	
Ethernet	2 x GbE LAN Ports (Intel® I211AT)	
Video	Integrated Graphics Processor - Intel® UHD Graphics for 10th Gen Intel® Processors: 2 x HDMI 2.0 port, supporting a maximum resolution of 4096x2160 @60Hz 1 x LVDS port, supporting a maximum resolution of 1920x1200 @60Hz (3 independent display outputs)	
Audio	Realtek® Audio Codec	
Storage	1 x SATA 6Gb/s Port	
Expansion Slots	1 x 2280 M.2 M-Key (PCIe x2, SATA 6Gb/s) 1 x Full-size mini PCIe with SIM slot	
Internal I/O	1 x 4-pin box power connector (+9V~36VDC) 1 x SATA Power header 1 x CPU fan header 1 x Front panel header 1 x Front panel audio header 1 x 2W Speaker out header 2 x USB 2.0 headers 1 x COM header (RS-232/422/485 & RI/5V/12V) 1 x COM header (RS-232/422/485) 2 x COM headers (RS-232) 1 x Backlight Control header 1 x AT/ATX mode select jumper 1 x GPIO (8 bits) & SMBus header 1 x Buzzer header	

Motherboard	QBiP-6412A	QBiP-6210A
Rear I/O	1 x Headphone Jack 2 x HDMI 2 x RJ45 LAN Ports 4 x USB 3.2 Gen 1	
OS Compatibility	Windows 10 (x64)	
Operating Properties	Operating temperature: 0°C to 60°C Operating humidity: 0-90% (non-condensing) Non-operating temperature: -40°C to 85°C Non-operating humidity: 0%-95% (non-condensing)	

Chapter 2

Chapter 2 – Hardware Information

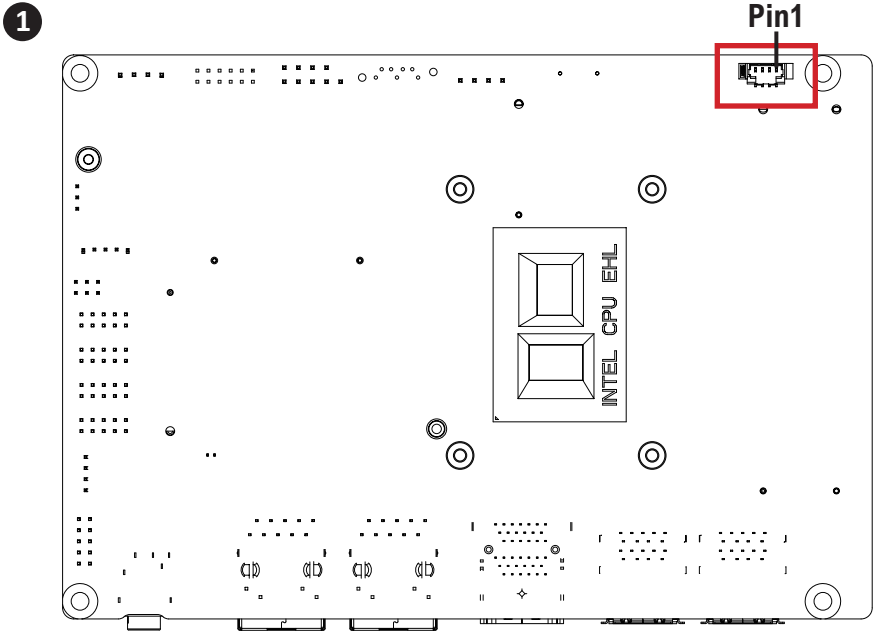
2.1 Jumpers and Connectors



No	Code	Description
1	FAN	FAN connector
2	DC_IN	DC IN 1x4pin power connector
3	AT_CN	AT/ATX mode select jumper
4	BKL_CN	Backlight Control connector
5	JCOM1	RI# pin RI#/5V/12V Select jumper for COM1 port
6	COM1 COM2 COM3 COM4	Serial port header COM1 : RS-232/422/485 & RI/5V/12V COM2 : RS-232/422/485 COM3, COM4 : RS-232
7	SPKR	Speaker out connector
8	FP_AUDIO	Front panel audio header
9	SODIMMA SODIMMB	DDR4 SO-DIMM sockets x 2
10	SYS_PANEL	Front panel header
11	M2M	M.2 slot, M-key, NGFF2280
12	SATAPW	SATA power connector
13	SATAIII	SATA 6Gb/s connector
14	FUSB20	USB 2.0 header
15	GPIO_CNT	General Purpose input/output header
16	LVDS	LVDS connector
17	LSW	LVDS resolution jumper
18	SIM_CARD	3G/4G SIM Slot
19	MPCIE	Mini-PCIe slot
20	BUZZER	Buzzer header
21	BATTERY	Battery cable connector

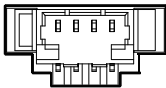
No	Code	Description
22	AUDIO	Line out connector
23	LAN1, LAN2	LAN connector
24	HDMI	HDMI connector
25	USB31_1, USB31_2	USB 3.2 Gen 1 connector x 4

2.2.1 FAN (FAN connector)



CPU/System FAN

4 3 2 1



Connector PN

85205-0470N

A1250WV-S-04PC

Vendor

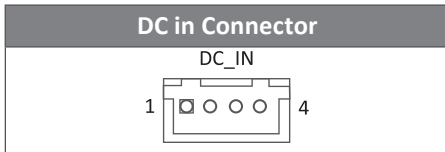
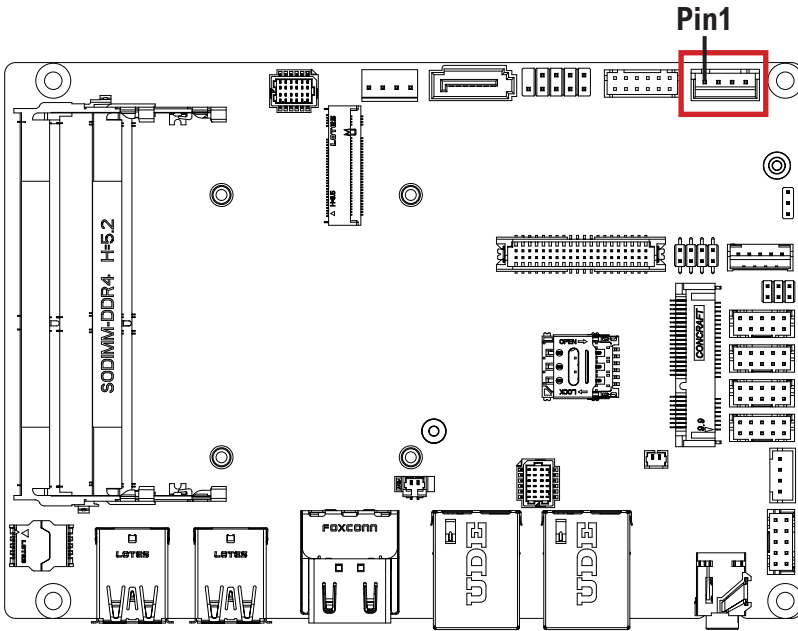
ACES

JOINT-TECH

Pin No.	Definition
1	GND
2	12V
3	Detect
4	Speed Control

2.2.2 DC_IN (DC IN 1x4pin power connector)

2

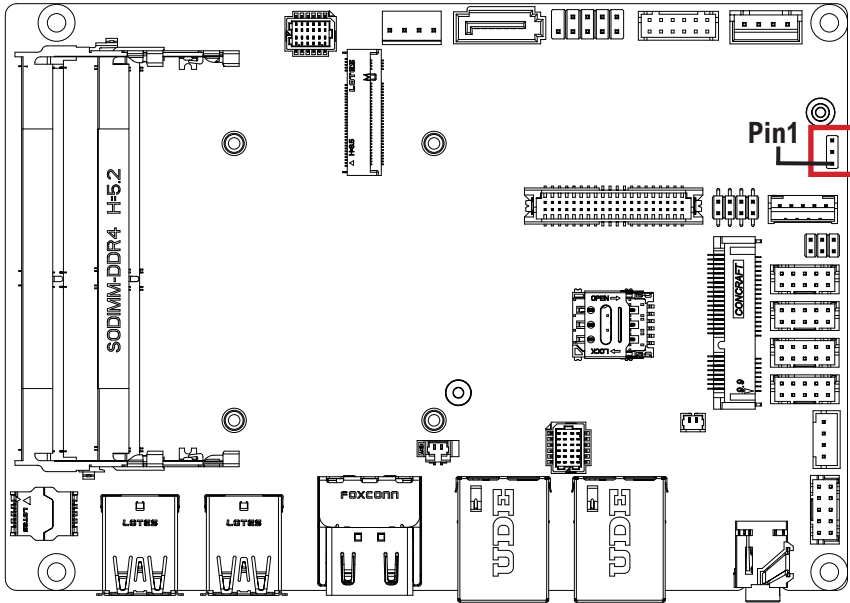


Connector PN	Vendor
753-81-04TW00	PINREX

Pin No.	Definition
1	GND
2	Power in
3	Power in
4	GND

2.2.3 AT_CN (AT/ATX mode select jumper)

3



AT/ATX mode select jumper



1-2 Close : AT mode.

2-3 Close : ATX mode.
(Default setting)

Connector PN

220-96-03GB01

PH03N2-7BAN000

Vendor

PINREX

HORNGTONG

Pin No.

Definition

1

AT MODE

2

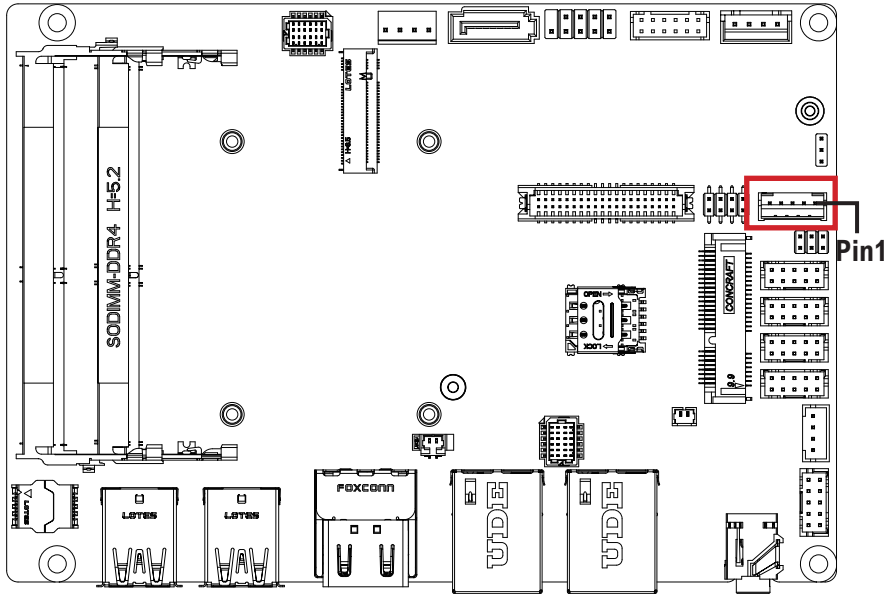
Detect

3

ATX MODE

2.2.4 BKL_CN (Backlight Control connector)

4



Backlight Control connector



Connector PN

721-81-05TW00

A2001WV-05P146

Vendor

PINREX

JOINT-TECH

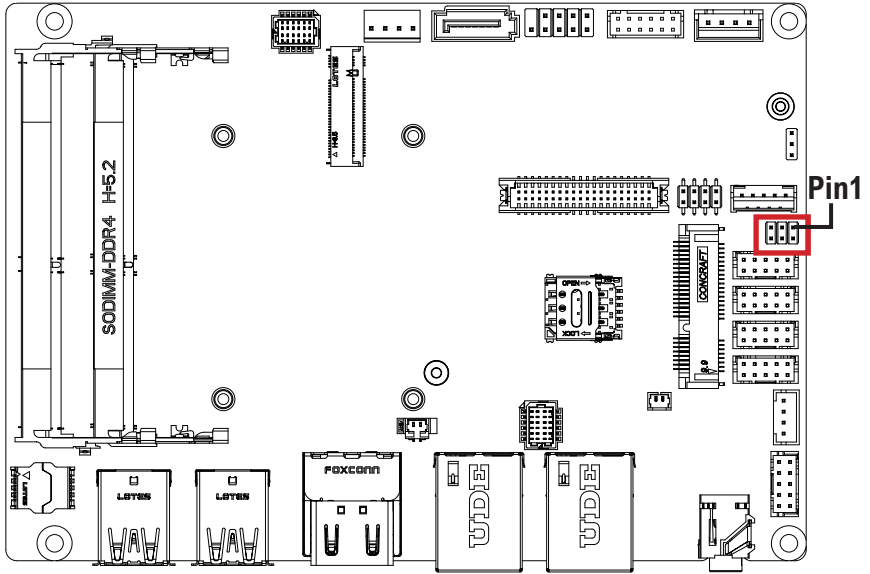
Pin No.

Definition

1	5V
2	PWM
3	Backlight Enable
4	GND
5	12V

2.2.5 JCOM1 (RI# pin RI#/5V/12V Select jumper for COM1 Port)

5

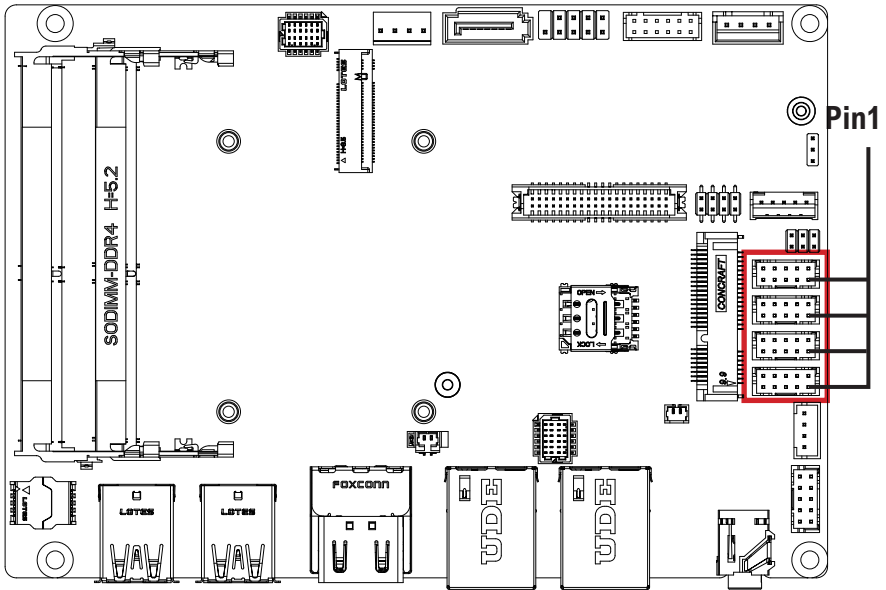


JCOM1 Jumper Select	
	1-2 Close: 5V (Power COM)
	3-4 Close: RI (Stand COM)
	5-6 Close: 12V (Power COM)

Connector PN	Vendor
220-97-03GB01	PINREX
PH06N53BAZ000	HORNGTONG

2.2.6 COM1, COM2, COM3, COM4 (Serial port header)

6



Serial Port Cable Connector



Pin No.	RS-232	RS-422 Full Duplex	RS-485 Half Duplex
1	RXD	TXD+	D+
2	DCD	TXD-	D-
3	DTR	RXD-	-
4	TXD	RXD+	-
5	DSR	-	-
6	GND	-	-
7	CTS	-	-
8	RTS	-	-
9	No Connect	-	-
10	RI/5V/12V	-	-

Connector PN

725-81-10TW00

A2004WV-2X05P46

Vendor

PINREX

JOINT-TECH

Note :

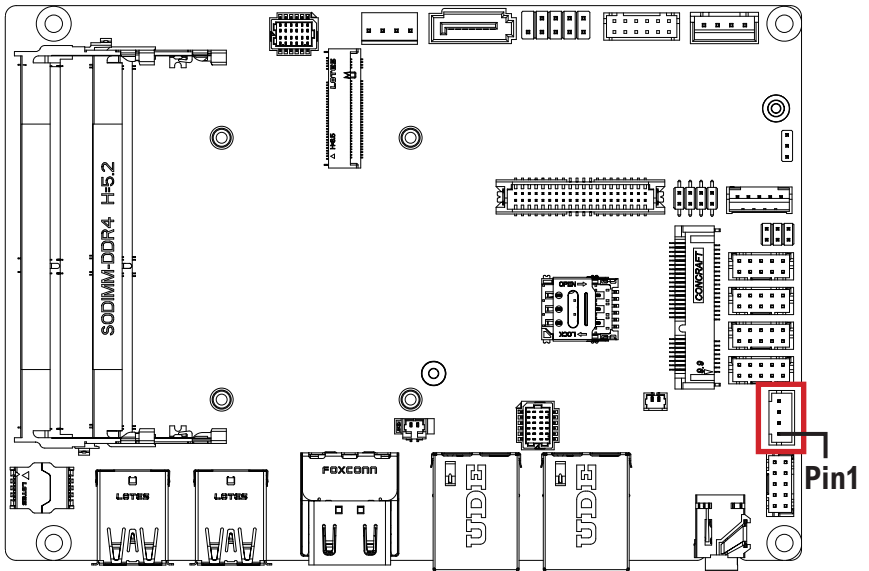
COM1 : Support RS-232/422/485 & RI/5V/12V
For RI/5V/12V jumper setting, please see P. 29

COM2 : Support RS-232/422/485

COM3, COM4 : Support RS-232 only

2.2.7 SPKR (Speaker out connector)

7



Speaker out connector



Connector PN

721-81-045W00
A2001WV-04P146

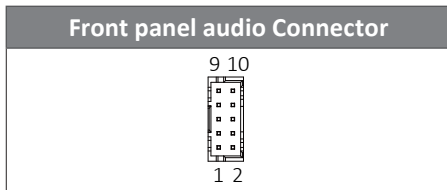
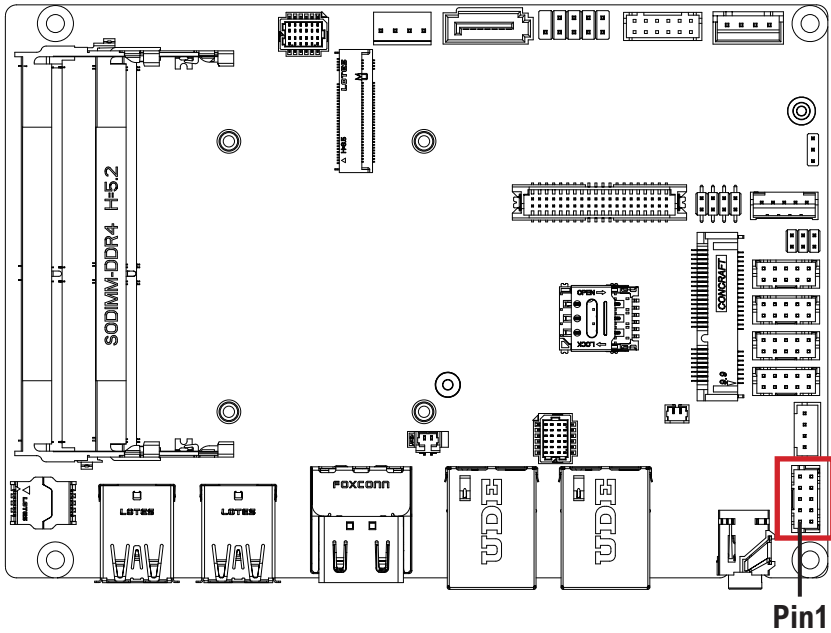
Vendor

PINREX
JOINT-TECH

Pin No.	Definition
1	Speaker Out L+
2	Speaker Out L-
3	Speaker Out R-
4	Speaker Out R+

2.2.8 FP_AUDIO (Front panel audio header)

8

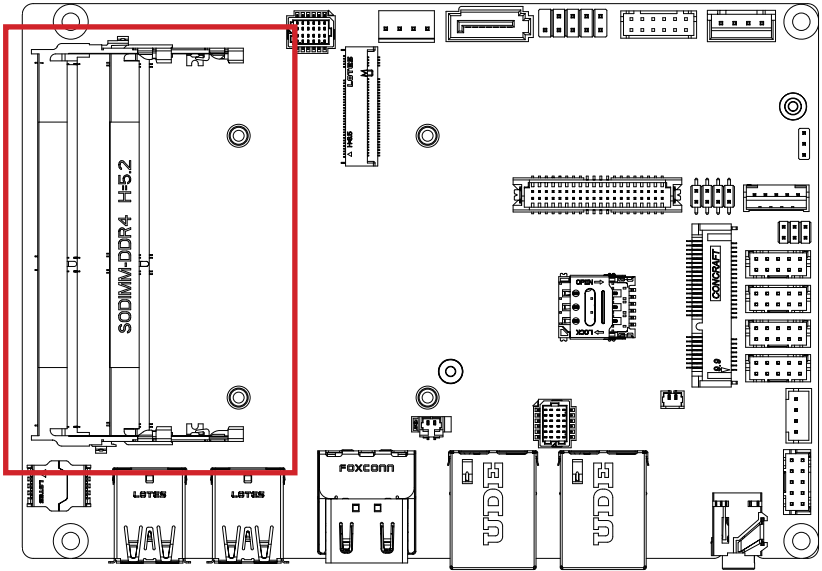


Connector PN	Vendor
725-81-10TW00	PINREX
A2004WV-2X05P46	JOINT-TECH

Pin No.	Definition
1	MIC-LEFT
2	GND
3	MIC-RIGHT
4	Detect
5	LINE-RIGHT
6	GND
7	JACKSENCE Detect
8	NC
9	LINE-LEFT
10	GND

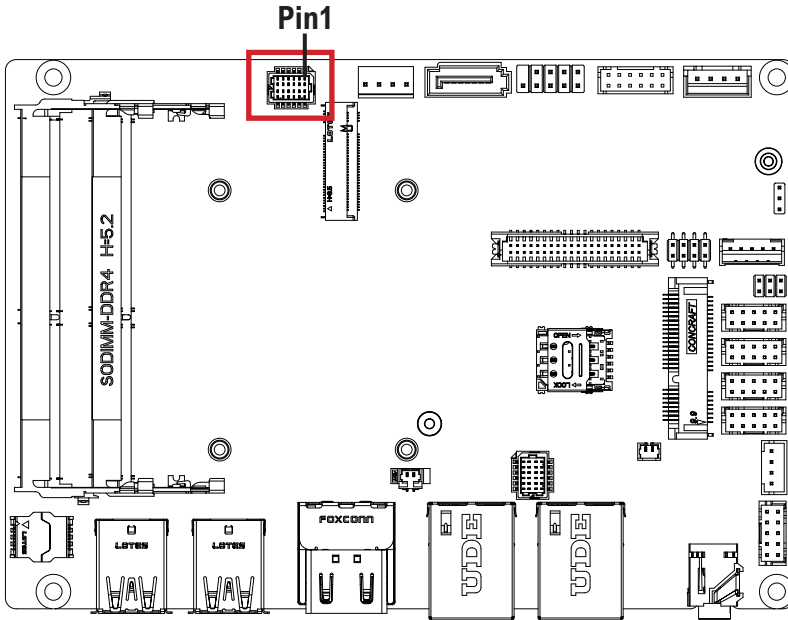
2.2.9 SODIMMA, SODIMMB (DDR4 SO-DIMM sockets)

9



2.2.10 SYS_PANEL (Front panel header)

10



System Panel Header



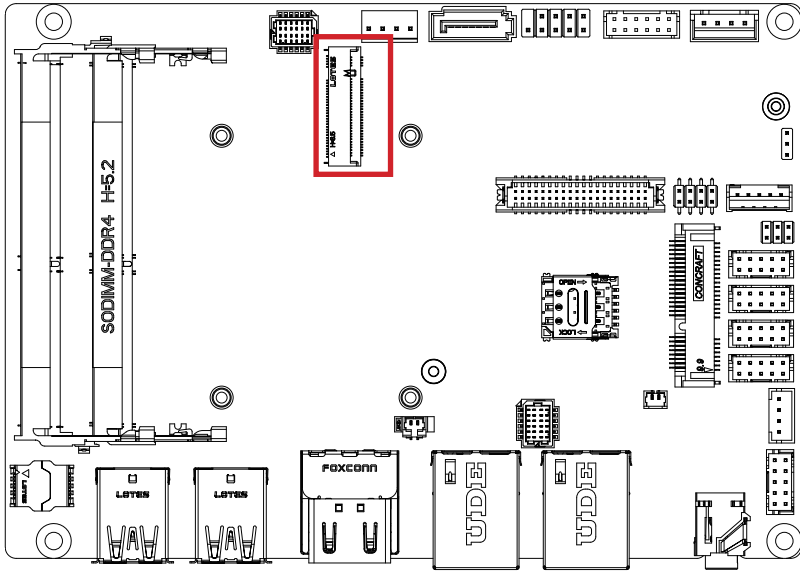
Pin No.	Definition
10	No Connect
11	No Connect
12	No Connect

Pin No.	Definition
1	HD-p
2	MPD-p
3	HD-n
4	MPD-n
5	GND
6	POWER-ON
7	Reset Button
8	GND
9	No Connect

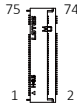
Connector PN	Vendor
87216-1206-06	ACES

2.2.11 M2M (M.2 Slot, M-Key, NGFF 2280)

11



M.2 M Key Connector



Pin No.	Definition	Pin No.	Definition
1	GND	2	3.3V
3	GND	4	3.3V
5	NC	6	NC
7	NC	8	NC
9	GND	10	SSD LED
11	NC	12	3.3V
13	NC	14	3.3V
15	GND	16	3.3V
17	NC	18	3.3V
19	NC	20	NC
21	GND	22	NC
23	NC	24	NC
25	NC	26	NC
27	GND	28	NC
29	PCI E1 RXn	30	NC
31	PCI E1 RXP	32	NC
33	GND	34	NC

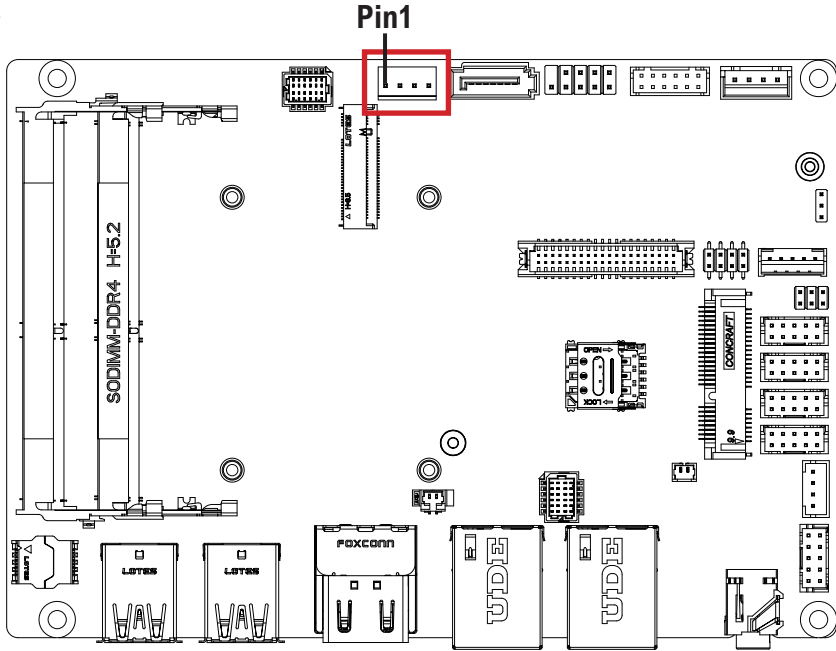
Pin No.	Definition	Pin No.	Definition
35	PCI E2 TXn	36	NC
37	PCI E2 TXp	38	NC
39	GND	40	NC
41	PCI E0 RXn/SATA Bp	42	NC
43	PCI E0 RXP/SATA Bn	44	NC
45	GND	46	NC
47	PCI E0 TXn/SATA An	48	NC
49	PCI E0 TXp/SATA Ap	50	PCI Reset
51	GND	52	PCI E Clock Request
53	PCI E Clock n	54	NC
55	PCI E Clock p	56	NC
57	GND	58	NC

Pin No.	Definition	Pin No.	Definition
67	NC	68	NC
69	Detect	70	3.3V
71	GND	72	3.3V
73	GND	74	3.3V
75	GND		

Connector PN	Vendor
80159-8521	BELLWETHER

2.2.12 SATAPW (SATA power connector)

12



Hard Disk Power Connector



Connector PN

743-51-04TW03

WF04Q2-3BJQ000

Vendor

PINREX

HORNGTONG

Pin No.

Definition

1

12V

2

GND

3

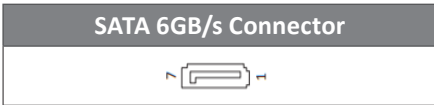
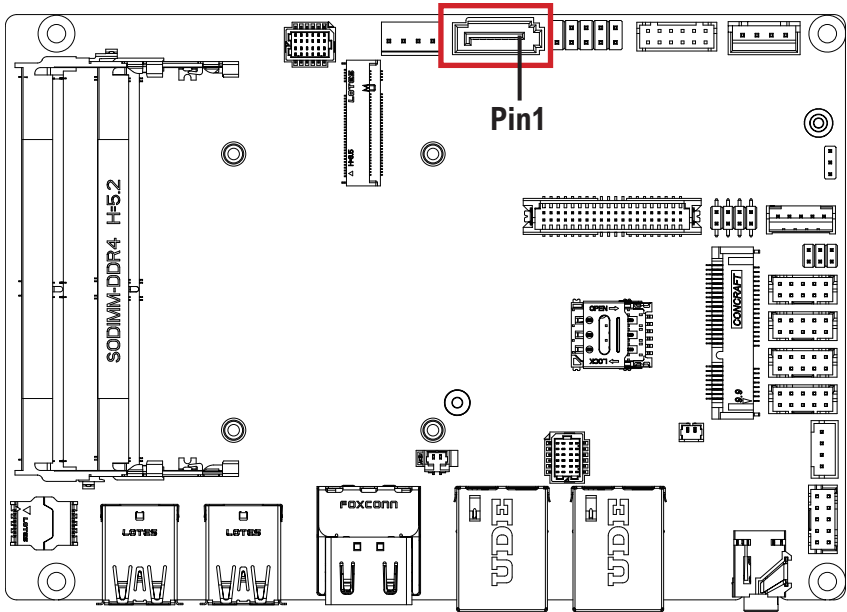
GND

4

5V

2.2.13 SATAIII (SATA 6Gb/s Connector)

13

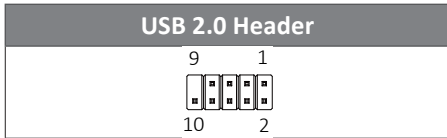
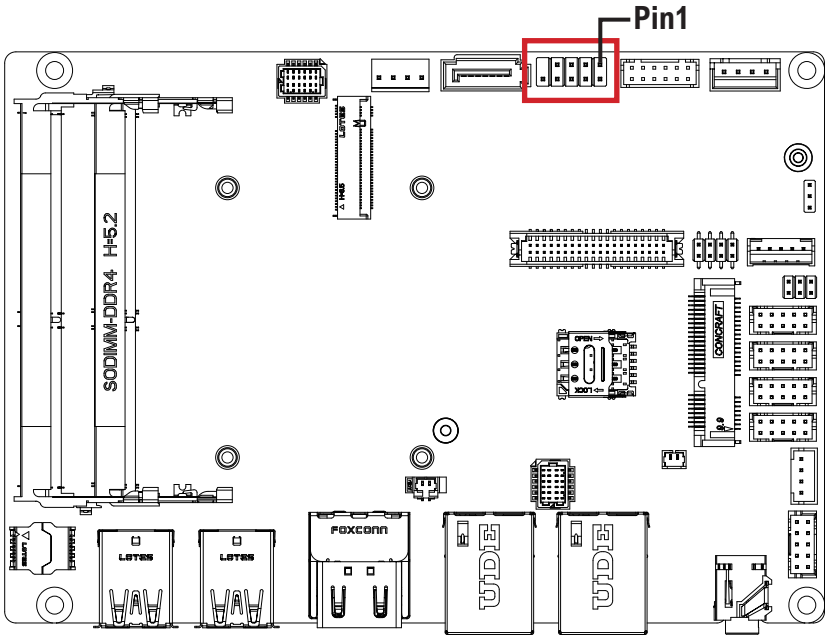


SATAIII	
Connector PN	Vendor
WAT3M-07A1G3BU4W	WINWIN
ABA-SAT-054-S15	LOTES

Pin No.	Definition
1	GND
2	TXp
3	TXn
4	GND
5	RXn
6	RXp
7	GND

2.2.14 FUSB20 (USB 2.0 header)

14

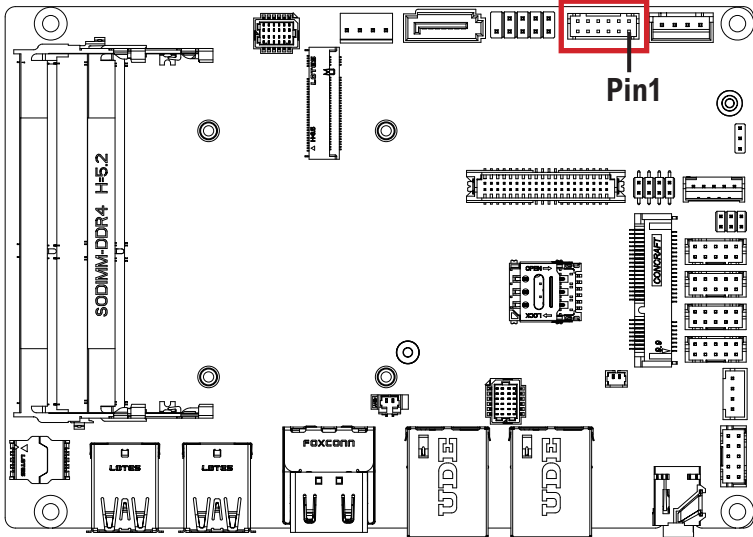


Connector PN	Vendor
210-92-05GB04	PINREX
PH10R53BAZ009	HORNGTONG

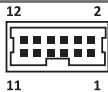
Pin No.	Definition
1	5V
2	5V
3	D2n
4	D1n
5	D2p
6	D1p
7	GND
8	GND
9	No Pin
10	No Connect

2.2.15 GPIO_CNT (General Purpose input/output header)

15



GPIO Connector



Connector PN

725-81-12TW00
A2004WV-2X06P46

Vendor

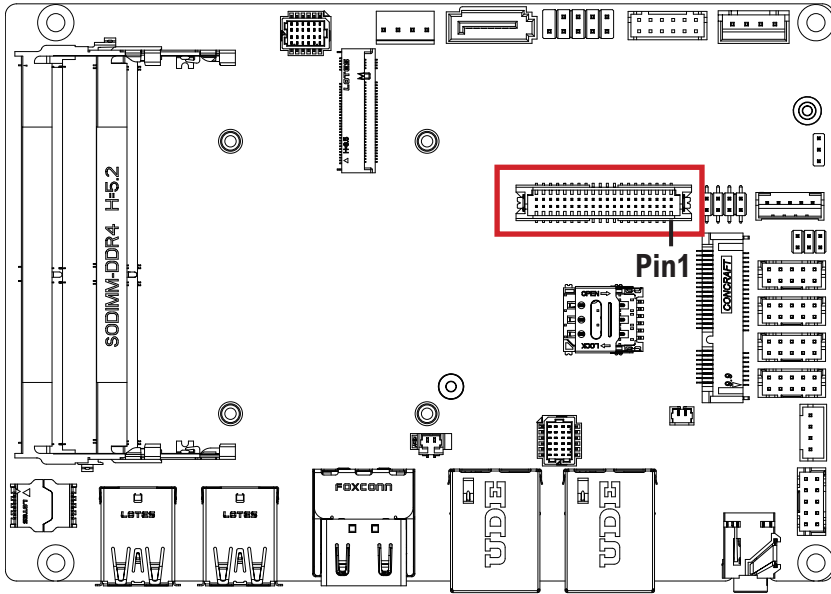
PINREX
JOINT-TECH

Pin No. Definition

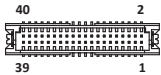
Pin No.	Definition
1	GPIO-output_1
2	GPIO-input_1
3	GPIO-output_2
4	GPIO-input_2
5	GPIO-output_3
6	GPIO-input_3
7	GPIO-output_4
8	GPIO-input_4
9	SMBus Clock
10	SMBus DATA
11	5V
12	GND

2.2.16 LVDS (LVDS connector)

16



LVDS Connector



Pin No.	Definition	Pin No.	Definition
17	A3-	37	GND
18	A2-	38	GND
19	GND	39	12V
20	GND	40	12V

Pin No.	Definition	Pin No.	Definition
1	3.3V	21	A5+
2	5V	22	A4+
3	3.3V	23	A5-
4	5V	24	A4-
5	SPECO	25	GND
6	SPEDO	26	GND
7	GND	27	A7+
8	GND	28	A6+
9	A1+	29	A7-
10	A0+	30	A6-
11	A1-	31	GND
12	A0-	32	GND
13	GND	33	CLK2+
14	GND	34	CLK1+
15	A3+	35	CLK2-
16	A2+	36	CLK1-

For each model support LVDS function.

But below model no need to add.

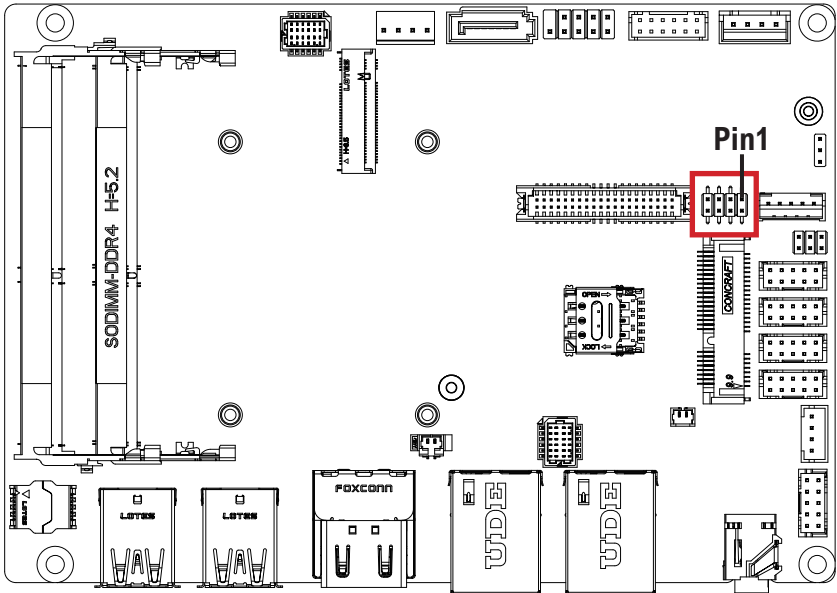
A0~A3 is odd channel 0~3, A4~A7 is even channel.

















Connector PN	Vendor
712-76-40GWEO	PINREX
A1252WV-SF-2X20PD01	JOINT-TECH

Note: *The LVDS output connector of the unit is only intended to be connected to an UL/IEC/EN approval equipment with fire enclosure.

2.2.17 LSW (LVDS resolution jumper)

17

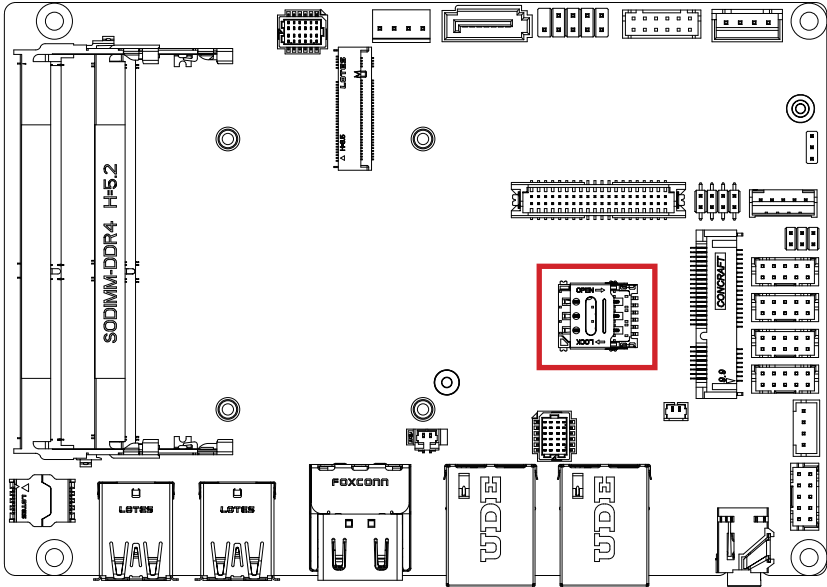


LVDS Resolution Jumper			
Jumper Setting	Resolution	Jumper Setting	Resolution
	800 x 600 18bit (default)		1366 x 768 24bit
	1024 x 768 18bit		1440 x 900 24bit
	1024 x 768 24bit		1400 x 1050 24bit
	1024 x 600 18bit		1600 x 900 24bit
	1280 x 800 18bit		1680 x 1050 24bit
	1280 x 960 18bit		1600 x 1200 24bit
	1280 x 1024 24bit		1920 x 1080 24bit
	1366 x 768 18bit		1920 x 1200 24bit

Connector PN	Vendor
222-97-04GBE1	PINREX

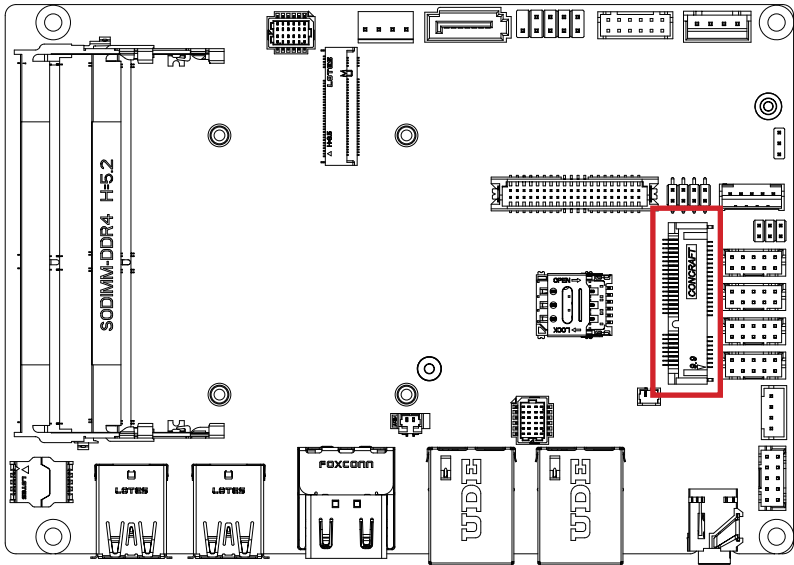
2.2.18 SIM_CARD (3G/4G SIM Slot)

18

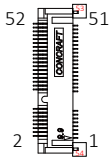


2.2.19 MPCIE (Mini PCIe slot)

19



Mini PCIe Connector



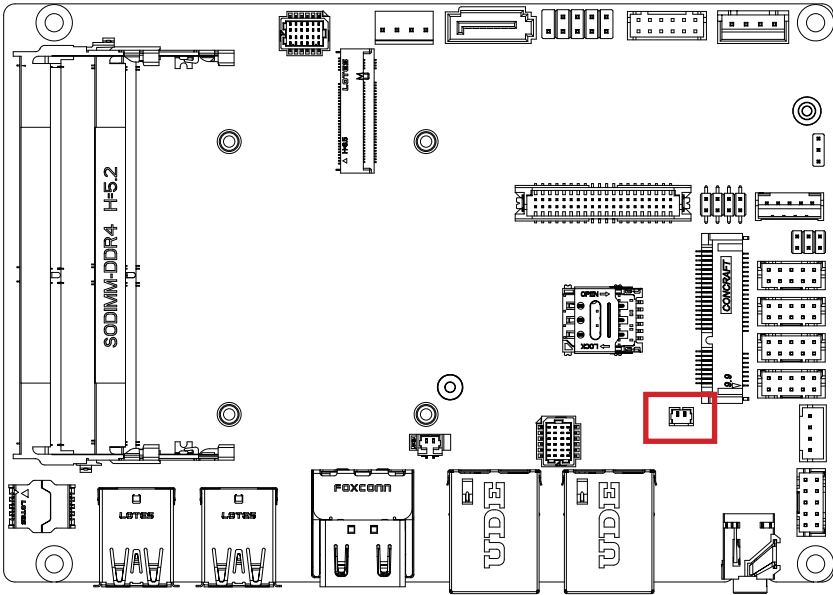
Pin No.	Definition	Pin No.	Definition
1	PCIE WAKE	2	3.3V
3	NC	4	GND
5	NC	6	NC
7	PCIE Clock Request	8	SIM VCC
9	GND	10	SIM DATA
11	PCIE Clock n	12	SIM Clock
13	PCIE Clock p	14	SIM Reset
15	GND	16	UIM VPP3
17	NC	18	GND
19	NC	20	WLAN_DISABLE
21	GND	22	Reset
23	PCIE RXn	24	3.3V
25	PCIE RXp	26	GND
27	GND	28	NC
29	GND	30	SMB Clock

Pin No.	Definition	Pin No.	Definition
31	PCIE TXn	32	SMB DATA
33	PCIE TXp	34	GND
35	GND	36	USB Dn
37	GND	38	USB Dp
39	3.3V	40	GND
41	3.3V	42	NC
43	GND	44	NC
45	NC	46	NC
47	NC	48	NC
49	NC	50	GND
51	NC	52	3.3V
53	GND	54	GND

Connector PN	Vendor
ASOB221-S99Q-7H	FOXCONN

2.2.20 BUZZER (Buzzer header)

20



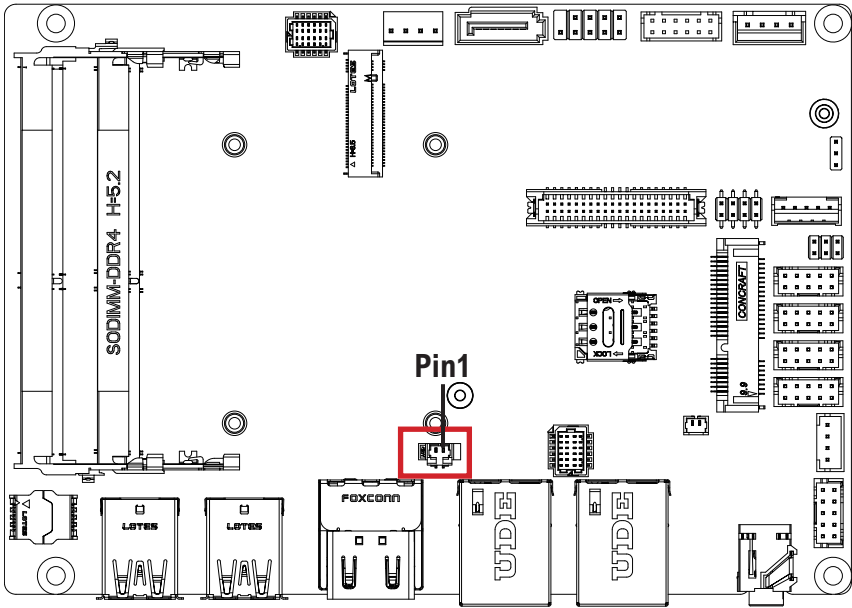
Buzzer header

Connector PN	Vendor
712-71-02TW01	PINREX
A1250WV-02P	JOINT-TECH

Pin No.	Definition
1	Buzzer
2	5V

2.2.21 BATTERY

21



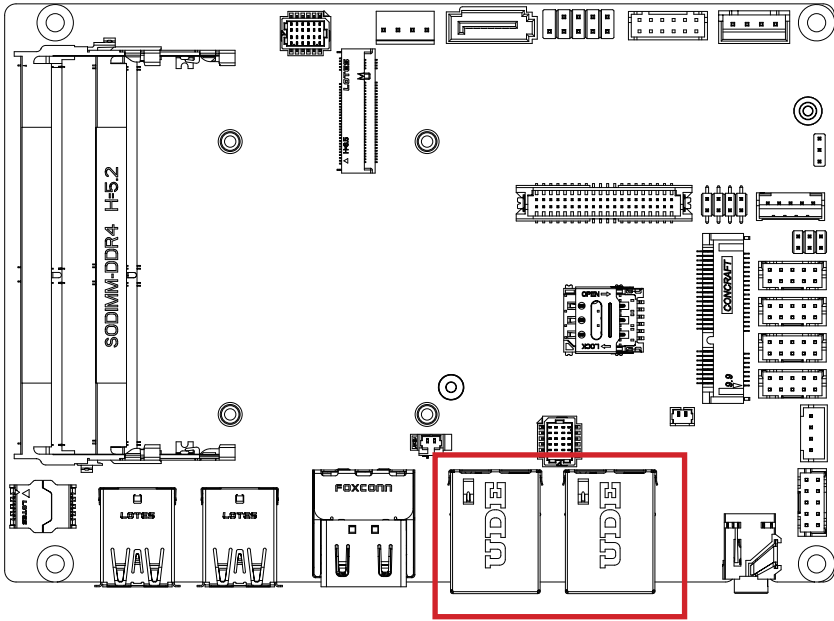
Battery Cable Connector	
2	1

Connector PN	Vendor
85205-0270L	ACES
A1250WV-S-02PC	JOINT-TECH

Pin No.	Definition
1	3V
2	GND

2.2.22 LAN1, LAN2 (LAN connector)

23



LAN Connector

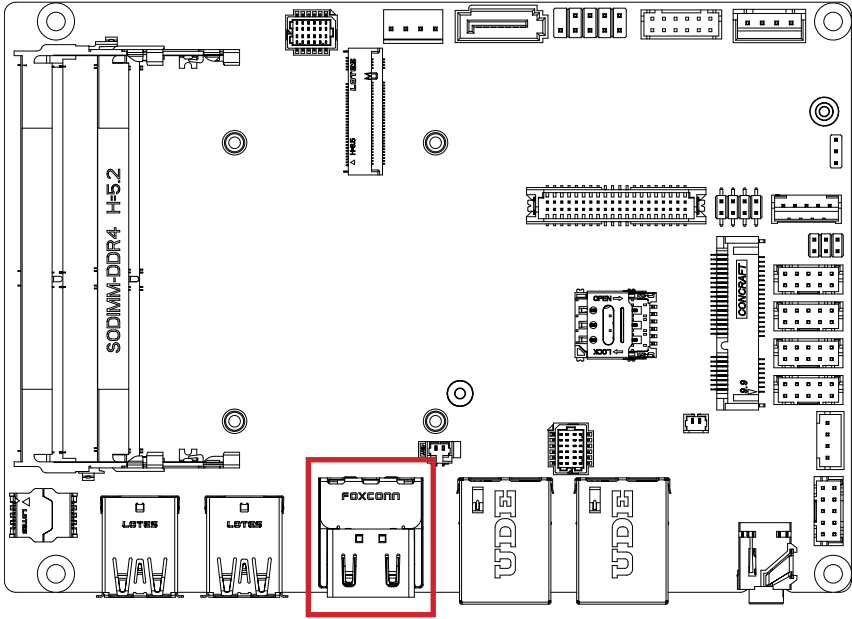


Status	Description
Orange On	1Gbps data rate
Green On	100Mbps data rate
Off	10Mbps data rate

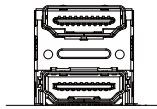
Pin No.	Definition
1	TX1+
2	TX1-
3	TX2+
6	TX2-
4	TX3+
5	TX3-
7	TX4+
8	TX4-

2.2.23 HDMI (HDMI connector)

24



HDMI Connector

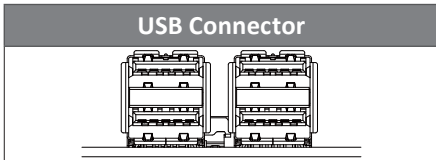
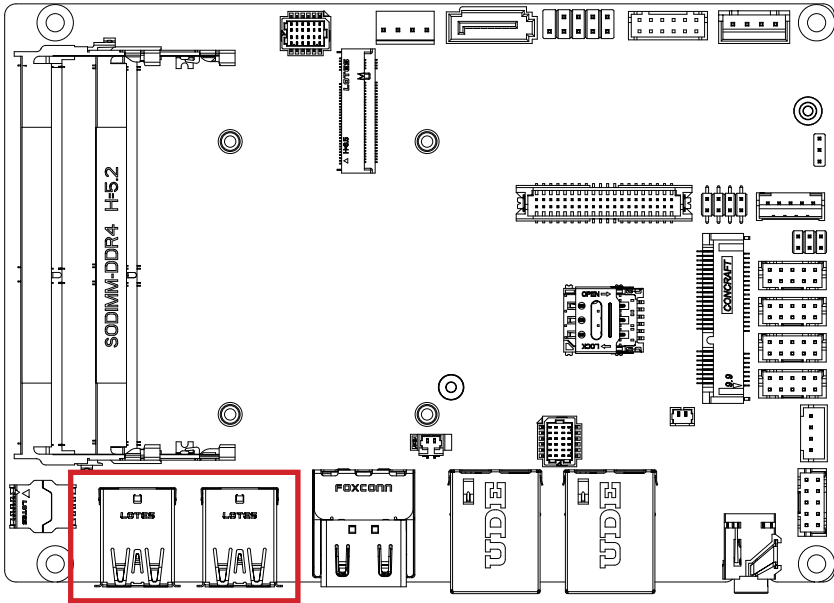


Pin No.	Definition	Pin No.	Definition
1	TX2p	20	TX2p
2	GND	21	GND
3	TX2n	22	TX2n
4	TX1p	23	TX1p
5	GND	24	GND
6	TX1n	25	TX1n
7	TX0p	26	TX0p
8	GND	27	GND
9	TX0n	28	TX0n
10	CLKp	29	CLKp
11	GND	30	GND

Pin No.	Definition	Pin No.	Definition
12	CLKn	31	CLKn
13	NC	32	NC
14	NA	33	NA
15	DDC Clock	34	DDC Clock
16	DDC Data	35	DDC Data
17	GND	36	GND
18	5V	37	5V
19	Hot Plug Detect	38	Hot Plug Detect

2.2.24 USB31_1, USB31_2 (USB 3.2 Gen 1 connector)

25



Pin No.	Definition
1	5V
2	D1n
3	D1p
4	GND
5	USB3_RX1n
6	USB3_RX1p
7	GND
8	USB3_TX1n
9	USB3_TX1p
10	5V

Pin No.	Definition
11	D0n
12	D0p
13	GND
14	USB3_RX2n
15	USB3_RX2p
16	GND
17	USB3_TX2n
18	USB3_TX2p

Chapter 3

Chapter 3 – BIOS

3.1 Introduction

BIOS (Basic input/output system) provides hardware detailed information and boot-up options, which include firmware to control, set-up and test all hardware settings. Therefore, BIOS is the communication bridge between OS/application software and hardware.

3.1.1 How to Entering into BIOS menu

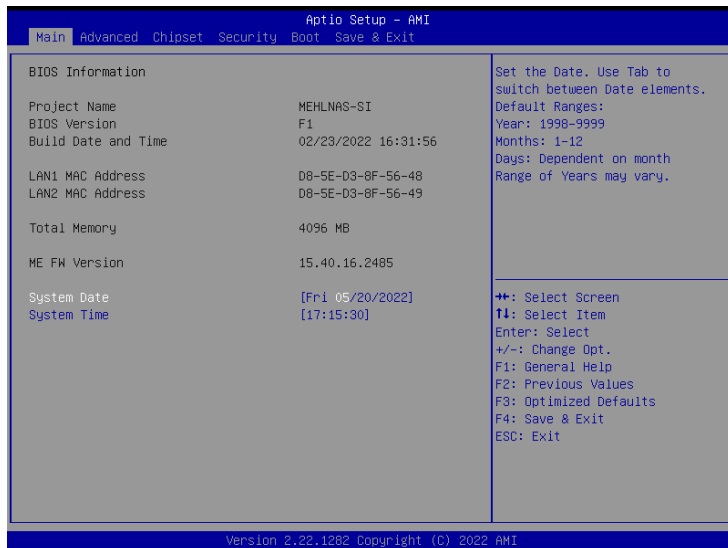
Once the system is power on, press the key as soon as possible to access into BIOS Setup program.

3.1.2 Function Keys to setup in BIOS Setup program

Function keys	Description
→←	Select Screen
↑↓	Select Item
Enter	Execute command or enter the submenu
+	Increase the numeric value or make changes
—	Decrease the numeric value or make changes
F1	General Help
F2	Previous Values
F3	Load Optimized Defaults Settings
F4	Save changes & Exit the BIOS Setup program
ESC	Exit the BIOS Setup program

3.2 The Main Menu

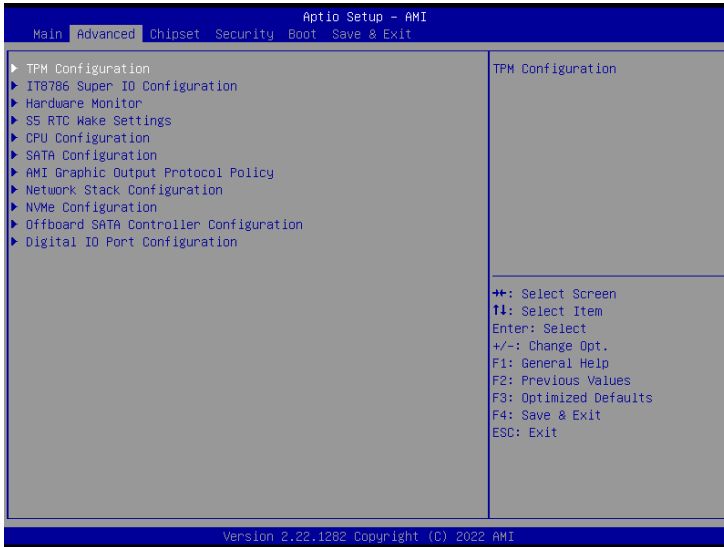
The main menu shows the basic system information. Use arrow keys to move among the items.



Items	Description
Project Name	Shows Project name information
BIOS Version	Shows the BIOS version of the system
Build Date and Time	Shows the Build Date and Time when the BIOS was created.
LAN1 MAC Address	Shows LAN1 MAC Address information
LAN2 MAC Address	Shows LAN2 MAC Address information
Total Memory	Shows the total memory size of the installed memory
ME FW version	Shows ME firmware version
System Date	Set the Date for the system (Format : Week - Month - Day - Year)
System Time	Set the time for the system (Format : Hour - Minute - Second)

3.3 Advanced

The Advanced menu is to configure the functions of hardware settings through submenu. Use arrow keys to move among the items, and press <Enter> to access into the related submenu.



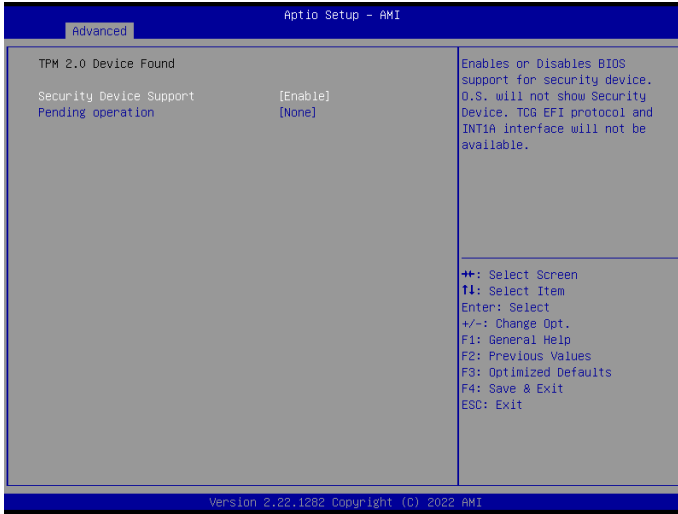
3.3.1 TPM Configuration

Use TPM Configuration submenu to choose TPM interface.



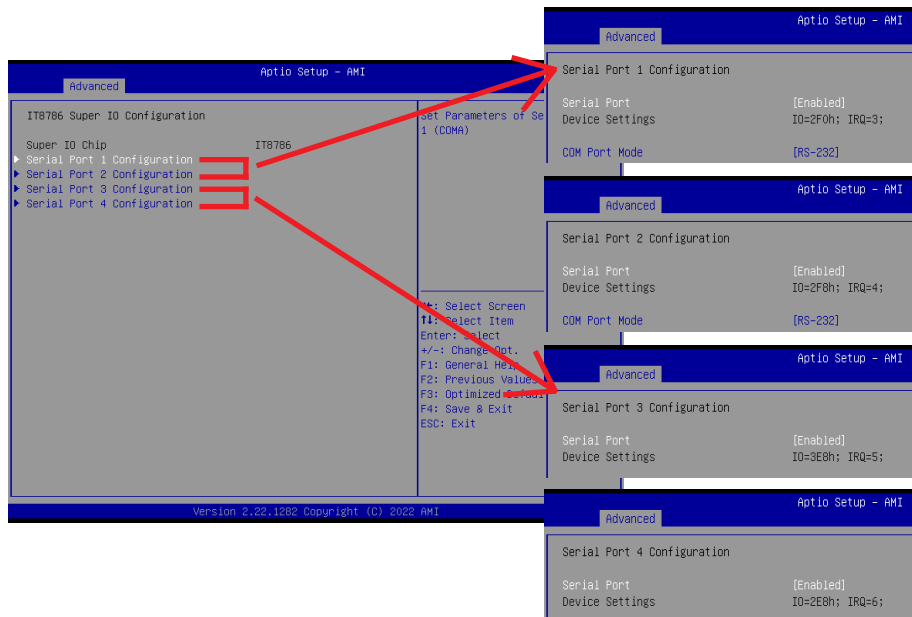
Item	Description
<p>TPM Device Selection</p>	<p>PTT : Internal TPM (Default setting)</p>

Trusted Computing : Shows TPM information, and TPM module configuration setting.



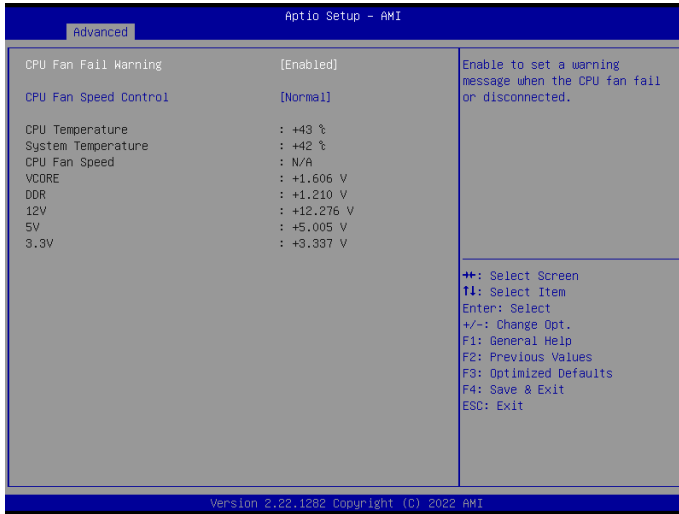
Item	Description
Security Device support	Enabled : Enables TPM feature (Default setting) Disabled : Disables TPM feature
Item	Description
Pending operation	None : No execution will be conducted (Default setting) TPM clear : Set to clear data on TPM

3.3.2 IT8786 Super IO Configuration



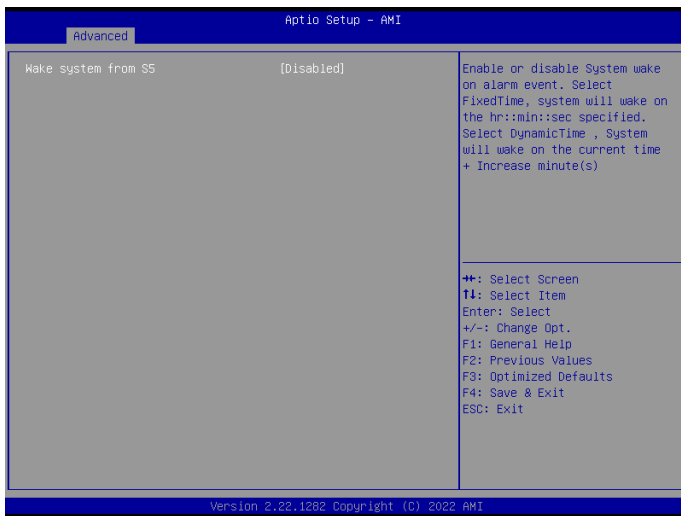
Item	Description
Super IO Chip	Shows Super I/O chip model
Serial Port 1 Configuration	Press [Enter] to configure advanced items : Serial Port : Enabled : Enables allows you to configure the serial port settings Disabled : if Disabled, displays no configuration for the serial port
Serial Port 2 Configuration	Device settings : Display the specified Serial Port base I/O address and IRQ COM Port Mode : Choose RS-232, RS-422, or RS-485 feature
Serial Port 3 Configuration	Press [Enter] to configure advanced items : Serial Port : Enabled : Enables allows you to configure the serial port settings Disabled : if Disabled, displays no configuration for the serial port
Serial Port 4 Configuration	Device settings : Display the specified Serial Port base I/O address and IRQ

3.3.3 Hardware Monitor



Item	Description
CPU Fan Fail Warning	Enabled : Enables CPU FAN Fail warning alert function (Default setting) Disabled : Disables CPU FAN Fail warning alert function
CPU Fan Speed Control	Normal : Fan speed set by BIOS default (Default setting) Full Speed : Set Fan operates at full speed
CPU temperature	Shows current CPU temperature
System temperature	Shows current system temperature
CPU Fan Speed	Shows current CPU fan Speed

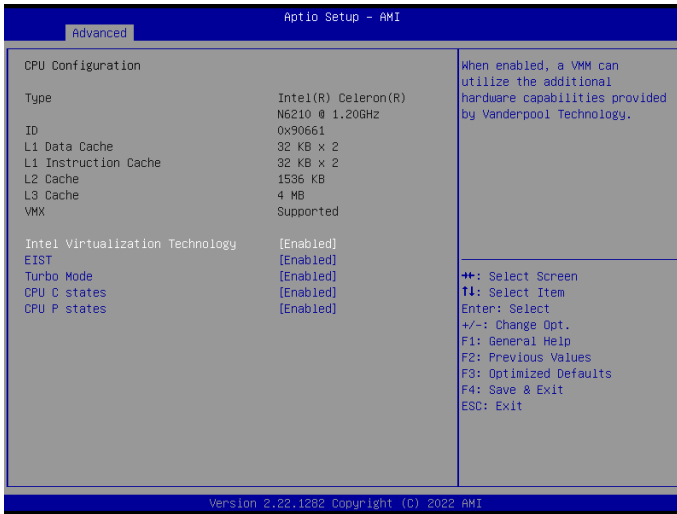
3.3.4 S5 RTC Wake Settings



Item	Description
<p>Wake system from S5</p>	<p>Enable or Disable System to wake on a specific time. Disabled : Disables system to wake on a specific time (Default setting) Fixed Time : Enables system to wake on a specific time (Format : hr : min : sec)</p>

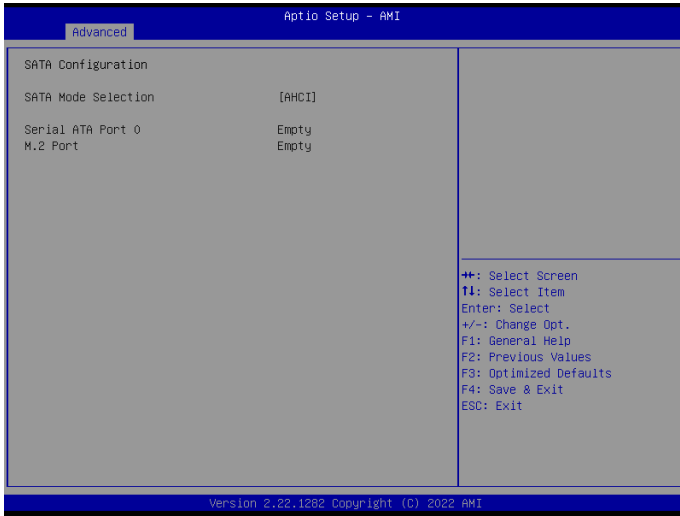
3.3.5 CPU Configuration

This submenu shows detailed CPU informations.



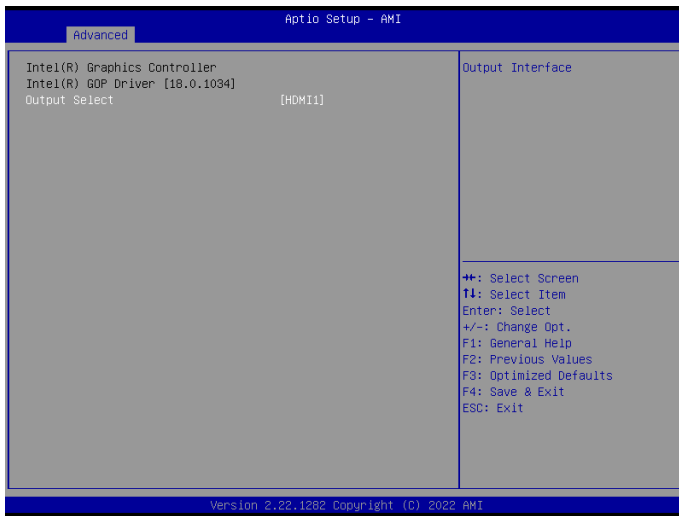
Item	Description
Intel Virtualization Technology	Virtualization enhanced by Intel® Virtualization Technology will allow a platform to run multiple operating systems and applications in independent partitions. With virtualization, one computer system can function as multiple virtual systems. Enabled : Enables Intel Virtualization Technology (Default setting) Disabled : Disables Intel Virtualization Technology
EIST	According to System loading, Enhanced Intel SpeedStep Technology (EIST) will automatically adjust the CPU voltage and core frequency to decrease heat and power consumption for power saving. Enabled : Enables EIST Technology (Default setting) Disabled : Disables EIST Technology
Turbo Mode	Enabled : Enables Turbo Mode (Default setting) Disabled : Disables Turbo Mode
CPU C states	Command CPU to enter into low power consumption mode when CPU is under idle mode. Enabled : Enables C states (Default setting) Disabled : Disables C states
CPU P states	CPU will adjust frequency depends on it's loading. Enabled : Enables CPU P states function (Default setting) Disabled : Disables CPU P states function

3.3.6 SATA Configuration



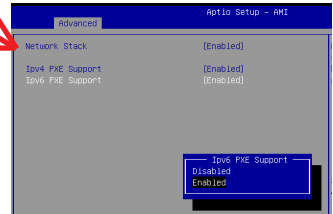
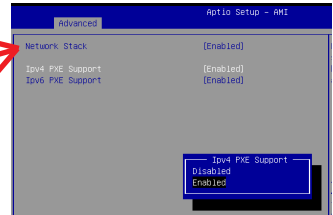
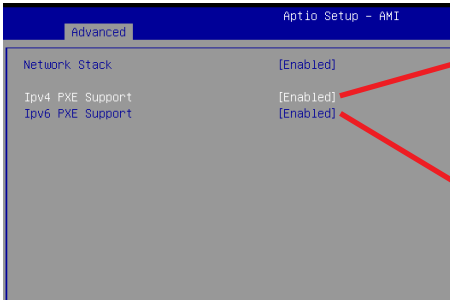
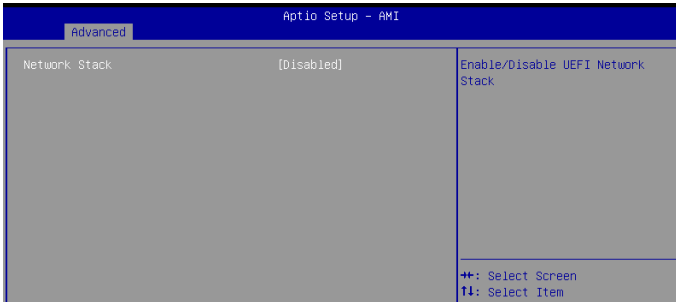
Item	Description
SATA Mode Selection	AHCI : Configures the SATA controllers to AHCI mode. (Default setting)
Serial ATA Port 0	shows 2.5" SATA HDD/SSD information
M.2	shows M.2 SATA interface SSD information

3.3.7 AMI Graphic Output Protocol Policy



Item	Description
Output Select	Choose default monitor output when there are more than one monitor plugged on the motherboard.

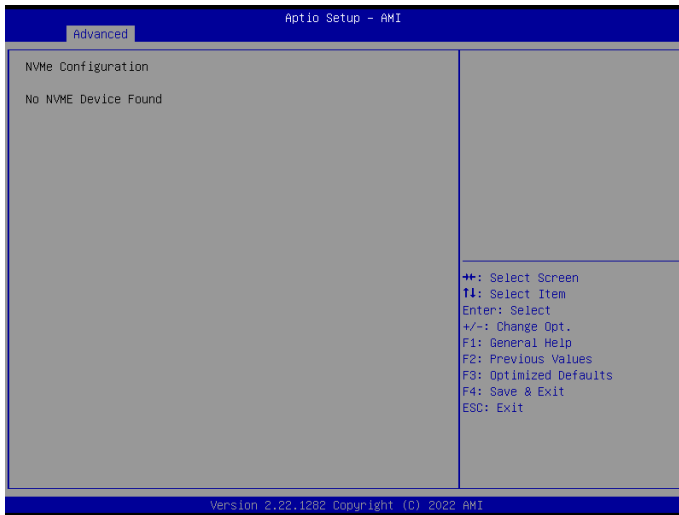
3.3.8 Network Stack Configuration



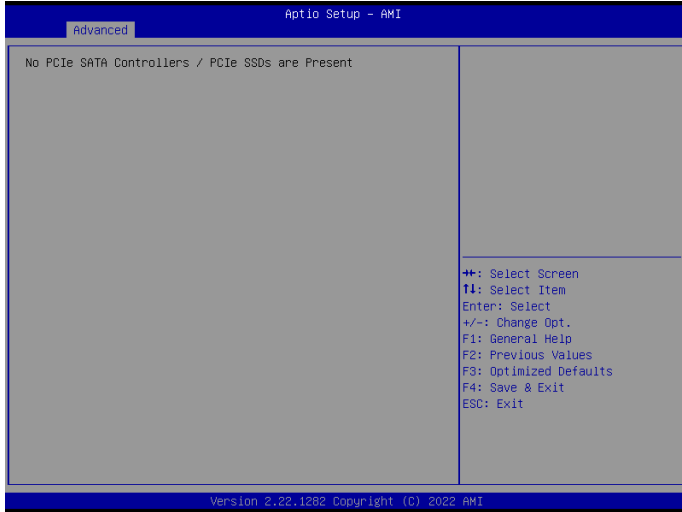
Item	Description
Network Stack	When system is power on, install LAN driver under UEFI mode Disabled : Disables UEFI Network Stack (Default setting) Enabled : Enables UEFI Network Stack
Ipv4 PXE Support	When Network stack is enabled : Disabled : Disables Ipv4 PXE Support Enabled : Enables Ipv4 PXE Support
Ipv6 PXE Support	When Network stack is enabled : Disabled : Disables Ipv6 PXE Support Enabled : Enables Ipv6 PXE Support

3.3.9 NVMe Configuration

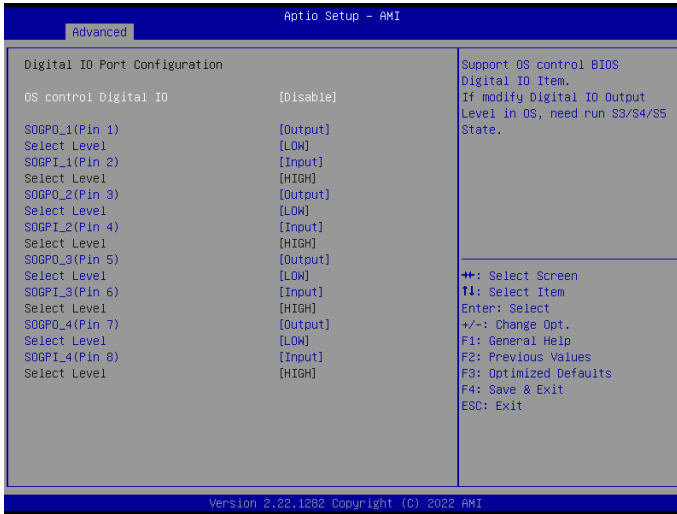
NVMe Configuration shows information when your M.2 NVMe PCIe SSD is installed.



3.3.10 Offboard SATA Controller Configuration

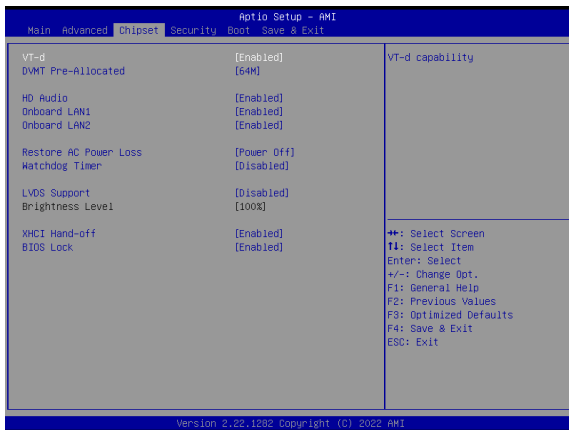


3.3.11 Digital IO Port Configuration



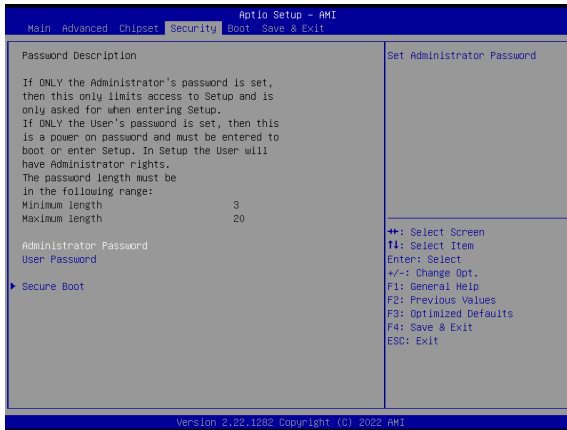
Item	Description
OS control Digital IO	<p>Disabled : If Digital IO Output value/level is modified in OS, they will not be memorized and kept. (Default setting)</p> <p>Enabled : If Digital IO Output value/level is modified in OS, they will be memorized and kept.</p>
<p>SOGPO_1 (Pin 1)</p> <p>SOGPI_1 (Pin 2)</p> <p>SOGPO_2 (Pin 3)</p> <p>SOGPI_2 (Pin 4)</p> <p>SOGPO_3 (Pin 5)</p> <p>SOGPI_3 (Pin 6)</p> <p>SOGPO_4 (Pin 7)</p> <p>SOGPI_4 (Pin 8)</p>	Configure Digital IO Input or Output values for each pin.

3.4 Chipset



Item	Description
VT-d	Enabled : Enables VT-d function (Default setting) Disabled : Disables VT-d function
DVMT Pre-Allocated	Use DVMT Pre-Allocated to set the amount of system memory which is installed to the integrated graphics processor Option items : 32M , 64M(Default setting) , 128M , 256M
HD Audio	Enable/Disable onboard audio controller Enabled : Enables onboard audio controller (Default setting) Disabled : Disables onboard audio controller
Onboard LAN1 Onboard LAN2	Enable/Disable onboard LAN controller Enabled : Enables onboard LAN controller (Default setting) Disabled : Disables onboard LAN controller
Restore AC Power Loss	To set which option the system should returns if a sudden power loss occurred Power off : Do not power on when the power is back (Default setting) Power on : System power on when the power is back Last state : Restore the system to the state before power loss occurs
Watchdog Timer	Enable/Disable Watchdog Timer function Enabled : Enables Watchdog Timer function Disabled : Disabled Watchdog Timer function (Default setting)
LVDS Support	Disabled : Disables LVDS Support (Default setting) Enabled : Enables LVDS Support
Brightness Level	To modified the backlight brightness of the LVDS panel Option items : 10% , 20% , 30% , 40% , 50% , 60% , 70% , 80% , 90% , 100% (Default Setting)
XHCI Hand-off	Enable/Disable XHCI Hand-off function Enabled : Enables XHCI Hand-off function (Default setting) Disabled : Disables XHCI Hand-off function
BIOS Lock	Enable/Disable BIOS Lock function Enabled : Enables BIOS Lock function (Default setting) Disabled : Disabled BIOS Lock funtion

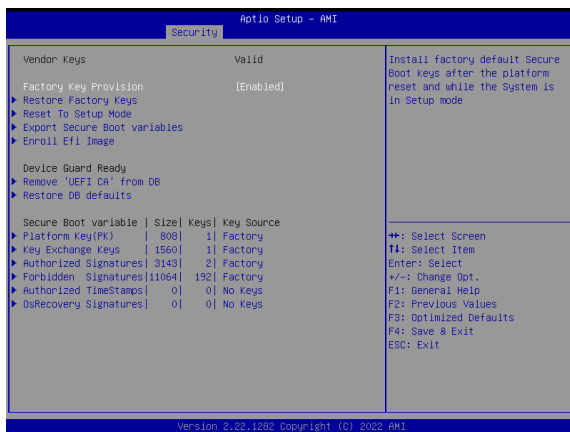
3.5 Security



Item	Description
Administrator Password	To set up Administrator's password Minimum length : 3 Maximum length : 20
User Password	To set up User's password Minimum length : 3 Maximum length : 20
Secure Boot	Press <Enter> to configure the advanced items



Item	Description
Secure Boot	Secure Boot requires all the applications that are running during the booting process to be pre-signed with valid digital certificates Enabled : Enables Secure Boot function Disabled : Disables Secure Boot function (Default setting)
Secure Boot Mode	Standard : Standard mode Custom : Custom mode (Default setting)
Restore Factory Keys	To restore factory settings Yes : Agree to restore factory settings No : Cancel to restore factory settings
Reset To Setup Mode	Yes : Agree to setup mode No : Cancel to setup mode
Key Management	Enables expert users to modify Secure boot policy variables without full authentication Press <Enter> to configure the advanced items



Item	Description
Factory Key Provision	Install factory default Secure Boot keys after the platform reset and while the system is in Setup mode Enabled : Enables Factory Key Provision (Default setting) Disabled : Disables Factory Key Provision
Restore Factory Keys	To restore factory settings Yes : Agree to restore factory settings No : Cancel to restore factory settings
Reset To Setup Mode	Yes : Agree to setup mode No : Cancel to setup mode
Export Secure Boot variables	Copy NVRAM content of Secure Boot variables to files in a root folder on a file system device
Enroll Efi Image	Allow the image to run in Secure Boot mode
Remove 'UEFI CA' from DB	To remove 'UEFI CA' from database Yes : Agree to remove 'UEFI CA' from database No : Cancel to remove 'UEFI CA' from database
Restore DB defaults	Restore DB variables to factory defaults Yes : Agree to restore DB defaults No : Cancel to restore DB defaults

Item	Description
Platform Key (PK)	These items allows you to enroll factory defaults or load Certificates from a file.
Key Exchange Keys	
Authorized Signatures	
Forbidden Signatures	
Authorized TimeStamps	
OsRecovery Signatures	

3.6 Boot

This Boot menu allows you to set/change system boot options



Item	Description
Full Screen LOGO Show	Enable/Disable full screen LOGO show on POST screen Enabled : Enables Full screen LOGO Show on POST screen Disabled : Disables Full screen LOGO Show on POST screen (Default setting)
Boot Option #1 Boot Option #2	Shows the information of the storage that be installed in the system Choose/set the boot priority

3.7 Save & Exit



Item	Description
Save Changes and Reset	After configuring all the options that you wish to change, choose this option to save all the changes and reboot the system Yes : Agree to save and reset No : Cancel to save and reset
Discard Changes and Reset	Choose this option to reboot the system without saving any changes Yes : Agree to discard changes and reset No : Cancel to discard changes and reset
Restore Defaults	Restore/Load default values for all the setup options Yes : Agree to load optimized defaults No : Cancel to load optimized defaults
Me FW Image Re-Flahs	Enable/Disable Me FW image re-flash function Enabled : Enables Me FW image re-flash function Disabled : Disables Me FW image re-flash function (Default setting)

QBiP-x6413EA/ QBiP-x6413EAT

3.5" SBC Boards
User's Manual 1st Ed

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Packing List

Before setting up your product, please make sure the following items have been shipped:

For QBiP-x6413EA :

Item	Quantity
QBiP-x6413EA	1
SATA power cable	1

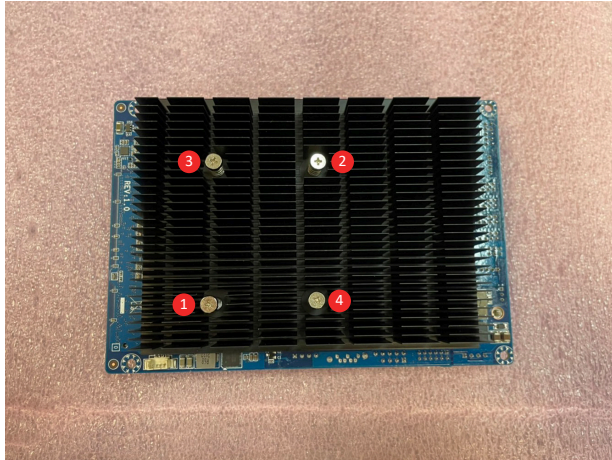
For QBiP-x6413EAT :

Item	Quantity
QBiP-x6413EAT	1
SATA power cable	1
Fanless Heatsink	1

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

Assembly Sequence

Fanless Heatsink assemble for QBiP-x6413EAT :



Torque	2.5 kgf-cm
Assembly action	
1>	Remove the release paper on the heatsink.
2>	Fix the heatsink with your hand to correct the corresponding hole position, and fix the heatsink as shown in the figure above.
3>	Follow above order to assemble the heatsink with the suggest torsion.
4>	When removing, please reverse (spinning from position 4) to disassemble the heatsink.

About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the GIGAIPC.com for the latest version of this document.

Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

1. All cautions and warnings on the device should be noted.
2. Make sure the power source matches the power rating of the device.
3. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
4. Always completely disconnect the power before working on the system's hardware.
5. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
6. If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
7. Always disconnect this device from any AC supply before cleaning.
8. While cleaning, use a damp cloth instead of liquid or spray detergents.
9. Make sure the device is installed near a power outlet and is easily accessible.
10. Keep this device away from humidity.
11. Place the device on a solid surface during installation to prevent falls
12. Do not cover the openings on the device to ensure optimal heat

dissipation.

13. Watch out for high temperatures when the system is running.
14. Do not touch the heat sink or heat spreader when the system is running
15. Never pour any liquid into the openings. This could cause fire or electric shock.
16. As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and contain all electronic components in any static-shielded containers.
17. If any of the following situations arises, please the contact our service personnel:
 - i. Damaged power cord or plug
 - ii. Liquid intrusion to the device
 - iii. Exposure to moisture
 - iv. Device is not working as expected or in a manner as described in this manual
 - v. The device is dropped or damaged
 - vi. Any obvious signs of damage displayed on the device
- 18. DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.**

FCC Statement

Warning!

This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

China RoHS Requirements (CN)

产品中有毒有害物质或元素名称及含量

GIGAIPC Main Board/ Daughter Board/ Backplane

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯 醚 (PBDE)
印刷电路板 及其电子组件	○	○	○	○	○	○
外部信号 连接器及线材	○	○	○	○	○	○
<p>○: 表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。</p> <p>X: 表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。</p> <p>备注: 此产品所标示之环保使用期限, 系指在一般正常使用状况下。</p>						

China RoHS Requirement (EN)

Poisonous or Hazardous Substances or Elements in Products
GIGAIPC Main Board/ Daughter Board/ Backplane

Component	Poisonous or Hazardous Substances or Elements					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)
PCB & Other Components	○	○	○	○	○	○
Wires & Connectors for External Connections	○	○	○	○	○	○

○: The quantity of poisonous or hazardous substances or elements found in each of the component's parts is below the SJ/T 11363-2006-stipulated requirement.
 X: The quantity of poisonous or hazardous substances or elements found in at least one of the component's parts is beyond the SJ/T 11363-2006-stipulated requirement.
 Note: The Environment Friendly Use Period as labeled on this product is applicable under normal usage only

Table Contents

3.5” SBC Boards	1
User’s Manual 1st Ed	
Copyright Notice	2
Acknowledgement	3
Packing List.....	4
Assembly Sequence	5
About this Document.....	6
Safety Precautions	7
FCC Statement.....	9
China RoHS Requirements (CN).....	10
China RoHS Requirement (EN)	11
Chapter 1 - Product Specifications	15
1.1 Specifications- QBiP-x6413EA/ QBiP-x6413EAT	17
Chapter 2 – Hardware Information	19
2.1 Jumpers and Connectors	20
2.2.1 FAN (FAN connector)	23
2.2.2 DC_IN (DC IN 1x4pin power connector)	24
2.2.3 AT_CN (AT/ATX mode select jumper).....	25
2.2.4 BKL_CN (Backlight Control connector)	26
2.2.5 JCOM1 (RI# pin RI#/5V/12V Select jumper for COM1 Port)	27
2.2.6 COM1, COM2, COM3, COM4 (Serial port header)	28
2.2.7 SPKR (Speaker out connector)	29

2.2.8	FP_AUDIO (Front panel audio header).....	30
2.2.9	SODIMMA, SODIMMB (DDR4 SO-DIMM sockets)	31
2.2.10	SYS_PANEL (Front panel header)	32
2.2.11	M2M (M.2 Slot, M-Key, NGFF 2280).....	33
2.2.12	SATAPW (SATA power connector).....	34
2.2.13	SATAIII (SATA 6Gb/s Connector)	35
2.2.14	FUSB20 (USB 2.0 header)	36
2.2.15	GPIO_CNT (General Purpose input/output header) ...	37
2.2.16	LVDS (LVDS connector).....	38
2.2.17	LSW (LVDS resolution jumper)	39
2.2.18	SIM_CARD (3G/4G SIM Slot)	40
2.2.19	MPCIE (Mini PCIe slot).....	41
2.2.20	BUZZER (Buzzer header).....	42
2.2.21	BATTERY	43
2.2.22	LAN1, LAN2 (LAN connector).....	44
2.2.23	HDMI (HDMI connector)	45
2.2.24	USB31_1, USB31_2 (USB 3.2 Gen 1 connector).....	46

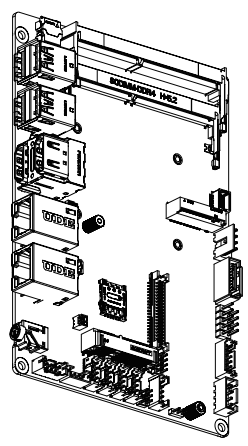
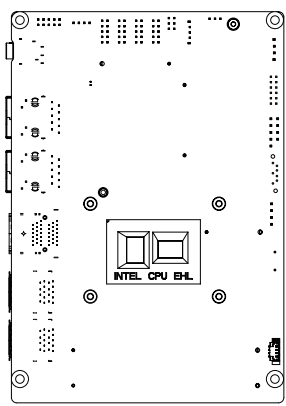
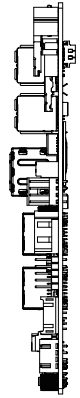
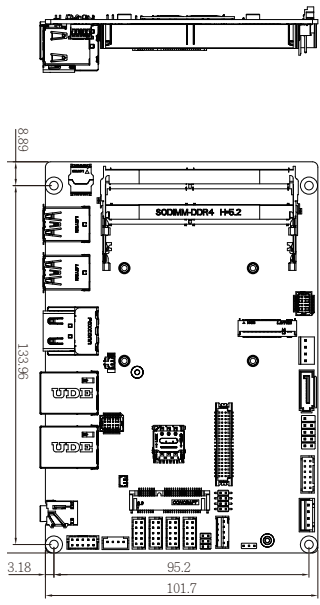
Chapter 3 – BIOS 47

3.1	Introduction	48
3.2	The Main Menu.....	49
3.2.1	The Main Menu for QBiP-x6413EA.....	49
3.2.2	The Main Menu for QBiP-x6413EAT	49
3.3	Advanced	51
3.3.1	TPM Configuration.....	52
3.3.2	IT8786 Super IO Configuration	54

3.3.3	Hardware Monitor	55
3.3.3.1	Hardware monitor items for QBiP-x6413EA	55
3.3.3.2	Hardware monitor items for QBiP-x6413EAT	56
3.3.4	S5 RTC Wake Settings	57
3.3.5	CPU Configuration	58
3.3.6	SATA Configuration	59
3.3.7	AMI Graphic Output Protocol Policy.....	60
3.3.8	Network Stack Configuration.....	61
3.3.9	NVMe Configuration	62
3.3.10	Offboard SATA Controller Configuration	63
3.3.11	Digital IO Port Configuration	64
3.4	Chipset	65
3.5	Security	66
3.6	Boot.....	69
3.7	Save & Exit	70

Chapter 1

Chapter 1 - Product Specifications QBiP-x6413EA / QBiP-x6413EAT



1.1 Specifications- QBiP-x6413EA/ QBiP-x6413EAT

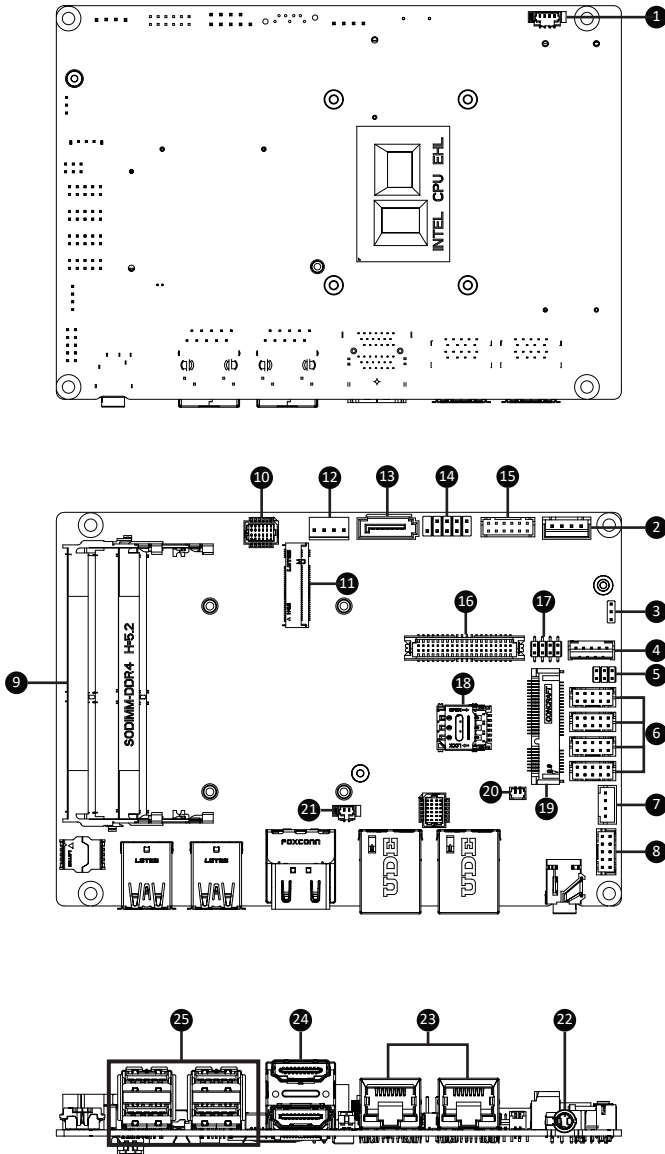
Motherboard	QBiP-x6413EA	QBiP-x6413EAT
Form Factor	3.5" SBC 146W x 101.7D (mm)	
CPU	Intel® Atom® x6413E Processor 10nm, 4 cores, 4 threads, up to 3.0 GHz TDP 9W	
Socket	1 x FCBGA1493	
Memory	2 x DDR4 SO-DIMM sockets, Max. Capacity 32 GB Support Dual Channel DDR4 3200 MHz memory modules	
Ethernet	2 x GbE LAN Ports	
Video	Integrated Graphics Processor - Intel® UHD Graphics for 10th Gen Intel® Processors: 2 x HDMI 2.0 port, supporting a maximum resolution of 4096x2160 @60Hz 1 x LVDS port, supporting a maximum resolution of 1920x1200 @60Hz (3 independent display outputs)	
Audio	Realtek® Audio Codec	
Storage	1 x SATA 6Gb/s Port	
Expansion Slots	1 x 2280 M.2 M-Key (PCIe x2, SATA 6Gb/s) 1 x Full-size mini PCIe with SIM slot	
Internal I/O	1 x 4-pin box power connector (DC in +9V~36VDC) 1 x SATA Power header 1 x CPU fan header 1 x Front panel header 1 x Front panel audio header 1 x 2W Speaker out header 2 x USB 2.0 headers 1 x COM header (RS-232/422/485 & RI/5V/12V) 1 x COM header (RS-232/422/485) 2 x COM headers (RS-232) 1 x Backlight Control header 1 x AT/ATX mode select jumper 1 x GPIO (8 bits) & SMBus header 1 x Buzzer header	

Motherboard	QBiP-x6413EA	QBiP-x6413EAT
Rear I/O	1 x Headphone Jack 2 x HDMI 2 x RJ45 LAN Ports 4 x USB 3.2 Gen 1	
OS Compatibility	Windows 10 (x64)	
Operating Properties	Operating temperature: 0°C to 60°C Operating humidity: 0-90% (non-condensing) Non-operating temperature: -40°C to 85°C Non-operating humidity: 0%-95% (non-condensing)	Operating temperature: -40°C to 85°C Operating humidity: 0-90% (non-condensing) Non-operating temperature: -40°C to 85°C Non-operating humidity: 0%-95% (non-condensing)

Chapter 2

Chapter 2 – Hardware Information

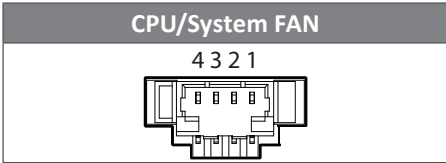
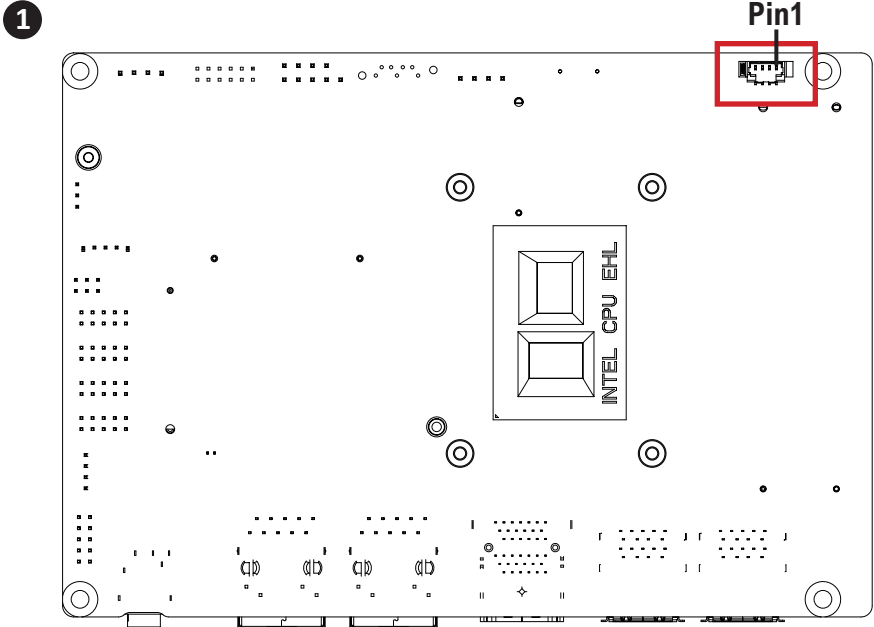
2.1 Jumpers and Connectors



No	Code	Description
1	FAN	FAN connector
2	DC_IN	DC IN 1x4pin power connector
3	AT_CN	AT/ATX mode select jumper
4	BKL_CN	Backlight Control connector
5	JCOM1	RI# pin RI#/5V/12V Select jumper for COM1 port
6	COM1 COM2 COM3 COM4	Serial port header COM1 : RS-232/422/485 & RI/5V/12V COM2 : RS-232/422/485 COM3, COM4 : RS-232
7	SPKR	Speaker out connector
8	FP_AUDIO	Front panel audio header
9	SODIMMA SODIMMB	DDR4 SO-DIMM sockets x 2
10	SYS_PANEL	Front panel header
11	M2M	M.2 slot, M-key, NGFF 2280
12	SATAPW	SATA power connector
13	SATAIII	SATA 6Gb/s connector
14	FUSB20	USB 2.0 header
15	GPIO_CNT	General Purpose input/output header
16	LVDS	LVDS connector
17	LSW	LVDS resolution jumper
18	SIM_CARD	3G/4G SIM Slot
19	MPCIE	Mini-PCIe slot
20	BUZZER	Buzzer header
21	BATTERY	Battery cable connector

No	Code	Description
22	AUDIO	Line out connector
23	LAN1, LAN2	LAN connector
24	HDMI	HDMI connector
25	USB31_1, USB31_2	USB 3.2 Gen 1 connector x 4

2.2.1 FAN (FAN connector)

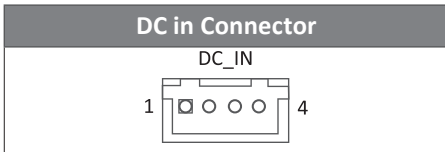
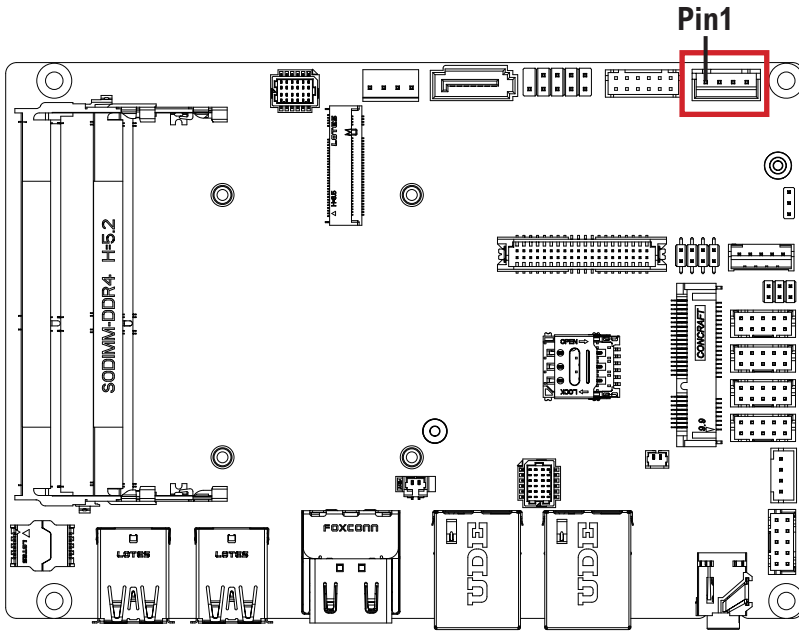


Connector PN	Vendor
85205-0470N	ACES
A1250WV-S-04PC	JOINT-TECH

Pin No.	Definition
1	GND
2	12V
3	Detect
4	Speed Control

2.2.2 DC_IN (DC IN 1x4pin power connector)

2

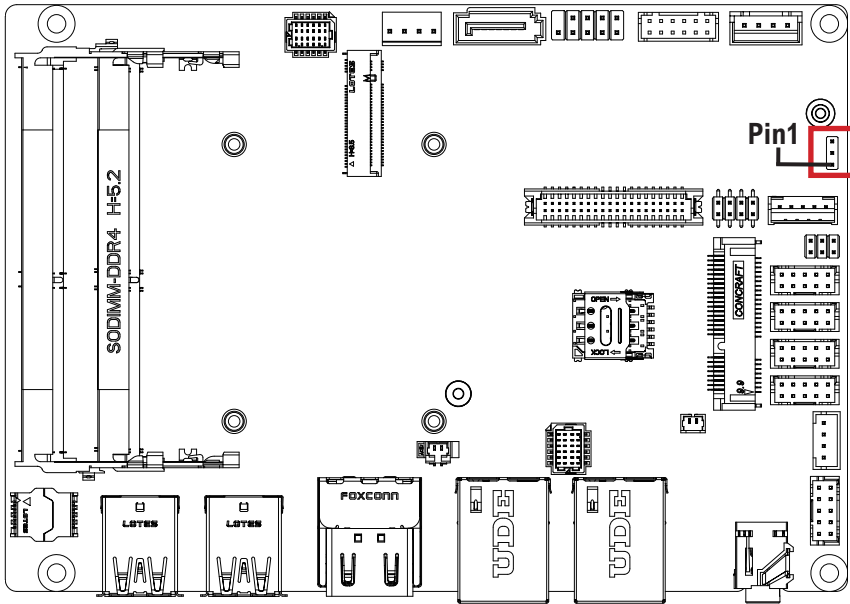


Connector PN	Vendor
753-81-04TW00	PINREX

Pin No.	Definition
1	GND
2	Power in
3	Power in
4	GND

2.2.3 AT_CN (AT/ATX mode select jumper)

3



AT/ATX mode select jumper



1-2 Close : AT mode.
2-3 Close : ATX mode.
(Default setting)

Connector PN

220-96-03GB01

Vendor

PINREX

Pin No.

Definition

1

AT MODE

2

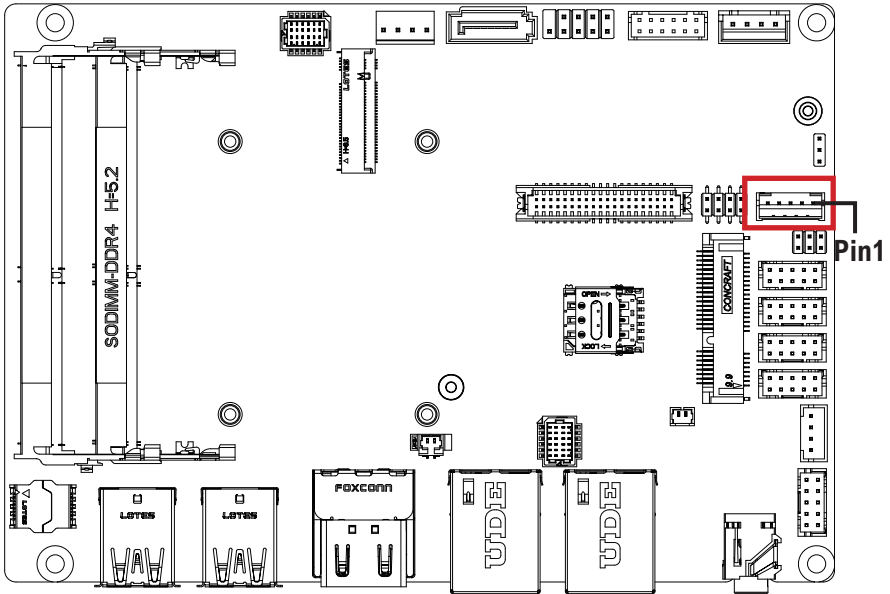
Detect

3

ATX MODE

2.2.4 BKL_CN (Backlight Control connector)

4



Backlight Control connector



Connector PN

721-81-05TW00

A2001WV-05P146

Vendor

PINREX

JOINT-TECH

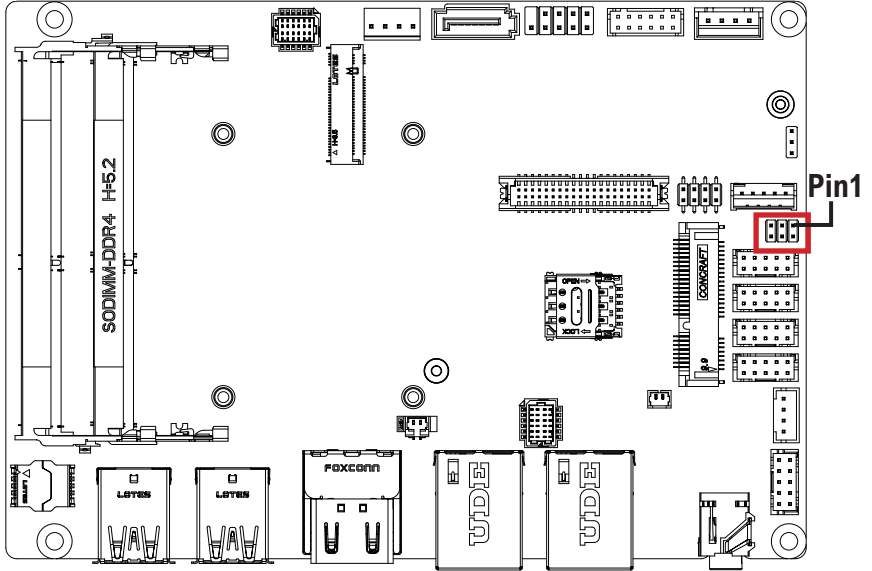
Pin No.

Definition

1	5V
2	PWM
3	Backlight Enable
4	GND
5	12V

2.2.5 JCOM1 (RI# pin RI#/5V/12V Select jumper for COM1 Port)

5



JCOM1 Jumper Select



1-2 Close:
5V (Power COM)



3-4 Close:
RI (Stand COM)



5-6 Close:
12V (Power COM)

Connector PN

220-97-03GB01

PH06N53BAZ000

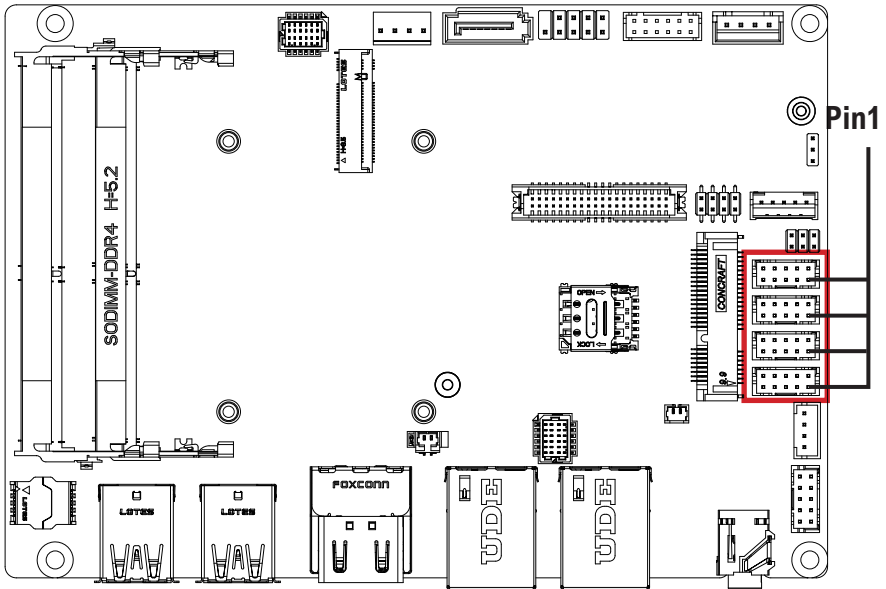
Vendor

PINREX

HORNGTONG

2.2.6 COM1, COM2, COM3, COM4 (Serial port header)

6



Serial Port Cable Connector



Pin No.	RS-232	RS-422 Full Duplex	RS-485 Half Duplex
1	RXD	TXD+	D+
2	DCD	TXD-	D-
3	DTR	RXD-	-
4	TXD	RXD+	-
5	DSR	-	-
6	GND	-	-
7	CTS	-	-
8	RTS	-	-
9	No Connect	-	-
10	RI/5V/12V	-	-

Connector PN

Vendor

725-81-10TW00

PINREX

A2004WV-2X05P46

JOINT-TECH

Note :

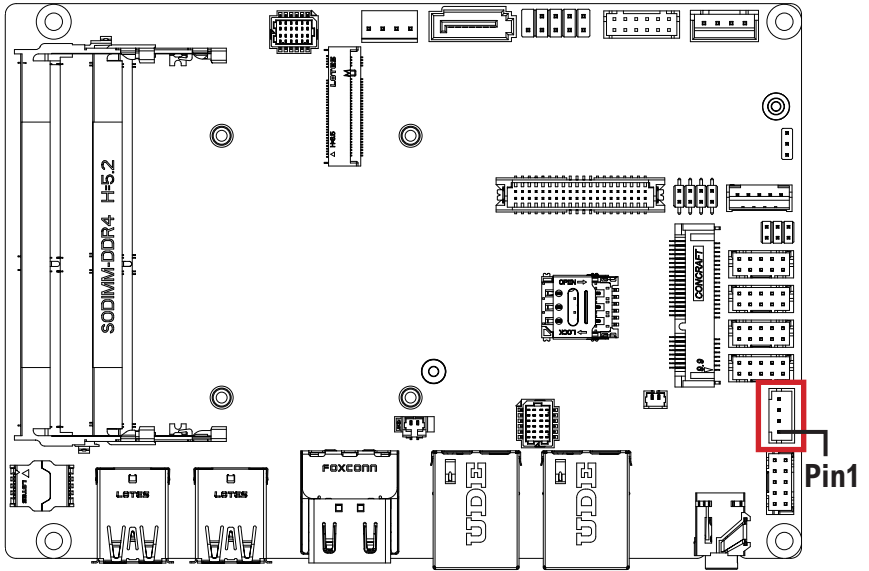
COM1 : Support RS-232/422/485 & RI/5V/12V
For RI/5V/12V jumper setting, please see P. 29

COM2 : Support RS-232/422/485

COM3, COM4 : Support RS-232 only

2.2.7 SPKR (Speaker out connector)

7



Speaker out connector

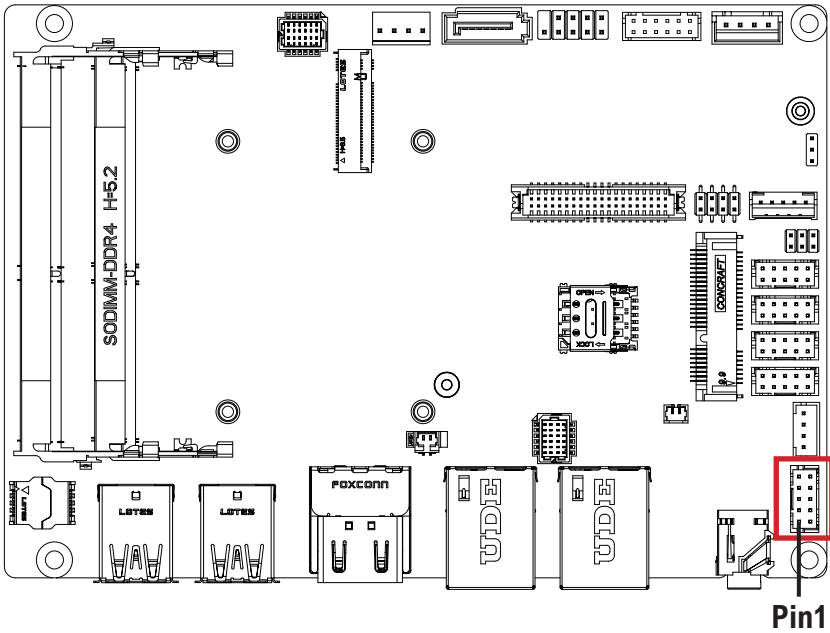


Pin No.	Definition
1	Speaker Out L+
2	Speaker Out L-
3	Speaker Out R-
4	Speaker Out R+

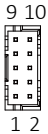
Connector PN	Vendor
721-81-045W00	PINREX
A2001WV-04P146	JOINT-TECH

2.2.8 FP_AUDIO (Front panel audio header)

8



Front panel audio Connector



Connector PN

725-81-10TW00

A2004WV-2X05P46

Vendor

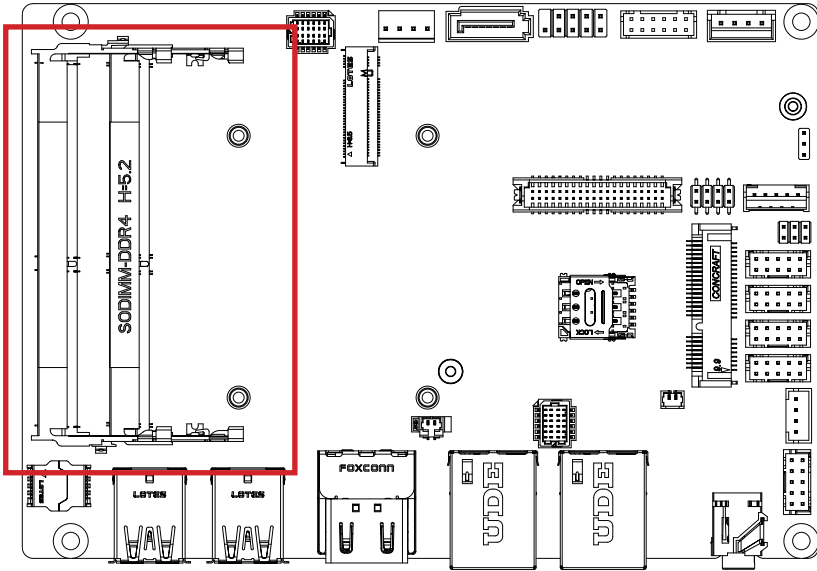
PINREX

JOINT-TECH

Pin No.	Definition
1	MIC-LEFT
2	GND
3	MIC-RIGHT
4	Detect
5	LINE-RIGHT
6	GND
7	JACKSENCE Detect
8	NC
9	LINE-LEFT
10	GND

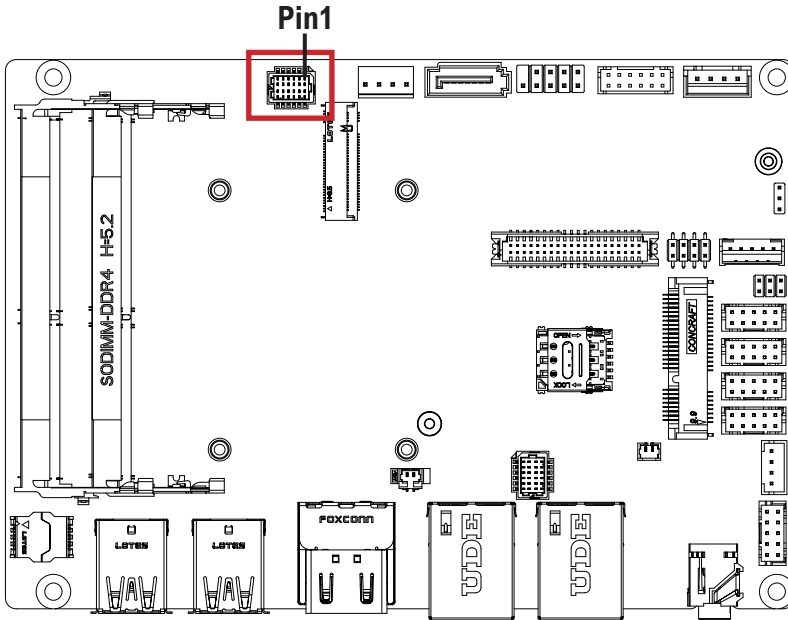
2.2.9 SODIMMA, SODIMMB (DDR4 SO-DIMM sockets)

9



2.2.10 SYS_PANEL (Front panel header)

10



System Panel Header



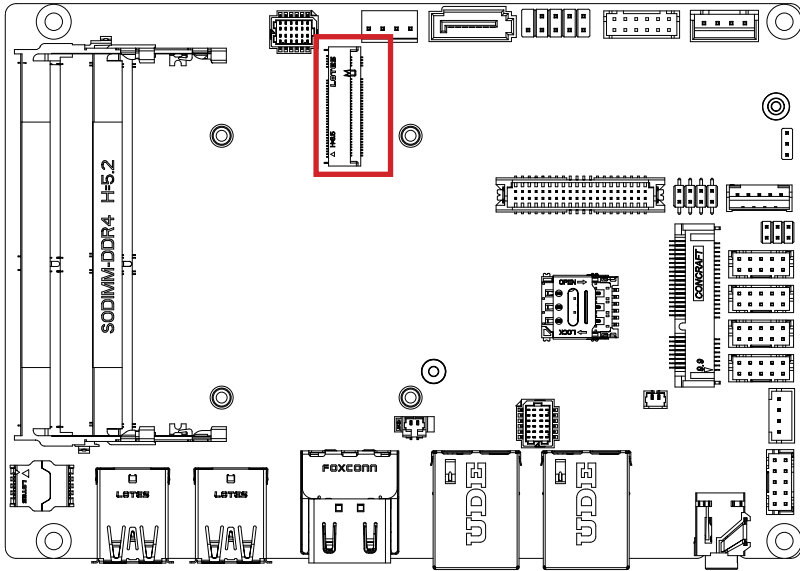
Pin No.	Definition
1	HD-p
2	MPD-p
3	HD-n
4	MPD-n
5	GND
6	POWER-ON
7	Reset Button
8	GND
9	No Connect

Pin No.	Definition
10	No Connect
11	No Connect
12	No Connect

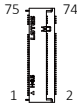
Connector PN	Vendor
87216-1206-06	ACES

2.2.11 M2M (M.2 Slot, M-Key, NGFF 2280)

11



M.2 M Key Connector



Pin No.	Definition	Pin No.	Definition
1	GND	2	3.3V
3	GND	4	3.3V
5	NC	6	NC
7	NC	8	NC
9	GND	10	SSD LED
11	NC	12	3.3V
13	NC	14	3.3V
15	GND	16	3.3V
17	NC	18	3.3V
19	NC	20	NC
21	GND	22	NC
23	NC	24	NC
25	NC	26	NC
27	GND	28	NC
29	PCI E1 RXn	30	NC
31	PCI E1 RXP	32	NC
33	GND	34	NC

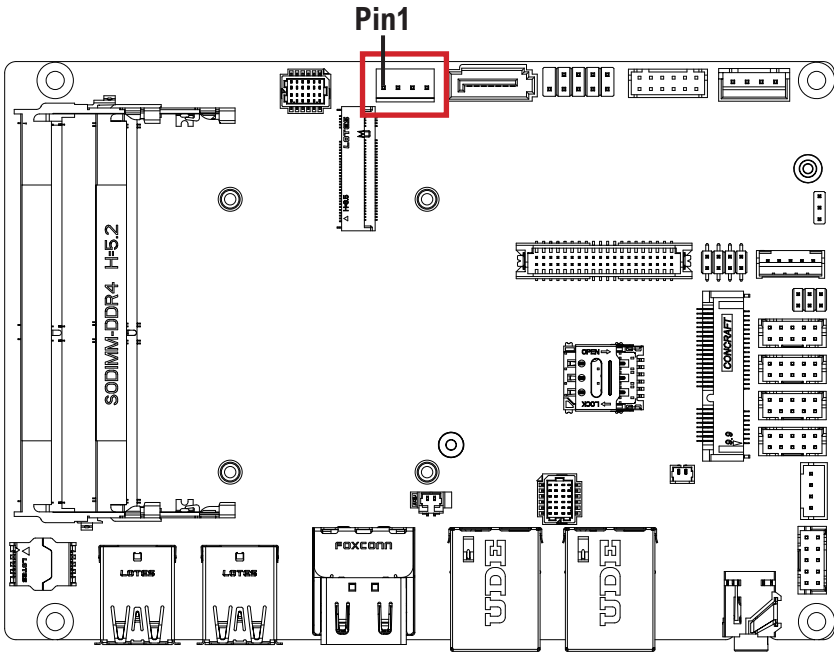
Pin No.	Definition	Pin No.	Definition
35	PCI E2 TXn	36	NC
37	PCI E2 TXp	38	NC
39	GND	40	NC
41	PCI E0 RXn/SATA Bp	42	NC
43	PCI E0 RXP/SATA Bn	44	NC
45	GND	46	NC
47	PCI E0 TXn/SATA An	48	NC
49	PCI E0 TXp/SATA Ap	50	PCI Reset
51	GND	52	PCI E Clock Request
53	PCI E Clock n	54	NC
55	PCI E Clock p	56	NC
57	GND	58	NC

Pin No.	Definition	Pin No.	Definition
67	NC	68	SUS_CLK
69	Detect	70	3.3V
71	GND	72	3.3V
73	GND	74	3.3V
75	GND		

Connector PN	Vendor
80159-8521	BELLWETHER

2.2.12 SATAPW (SATA power connector)

12



Hard Disk Power Connector



Connector PN

743-81-04TW00

Vendor

PINREX

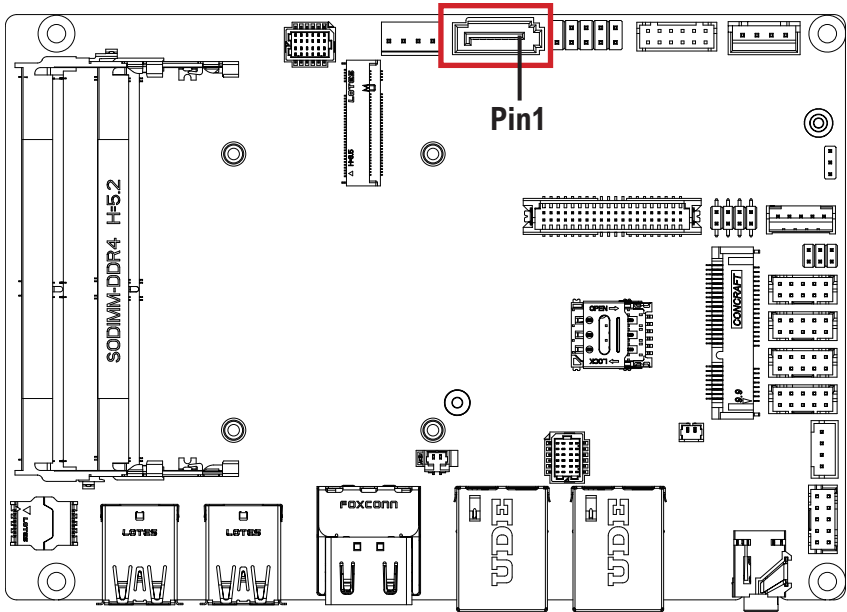
Pin No.

Definition

1	12V
2	GND
3	GND
4	5V

2.2.13 SATAIII (SATA 6Gb/s Connector)

13



SATA 6GB/s Connector



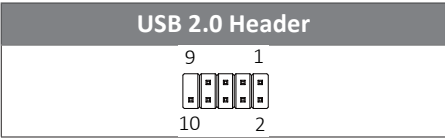
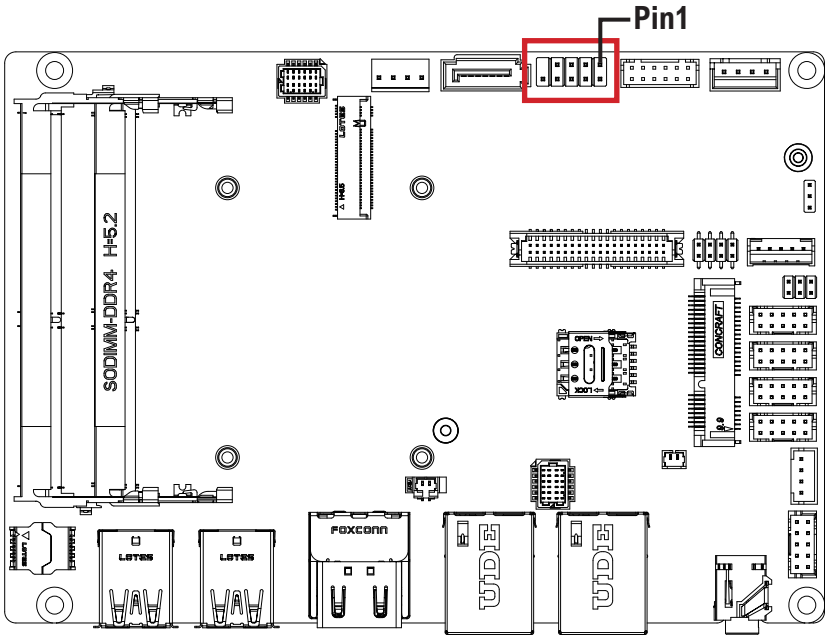
SATAIII

Connector PN	Vendor
WAT3M-07A1G3BU4W	WINWIN
ABA-SAT-054-S15	LOTES

Pin No.	Definition
1	GND
2	TXp
3	TXn
4	GND
5	RXn
6	RXp
7	GND

2.2.14 FUSB20 (USB 2.0 header)

14

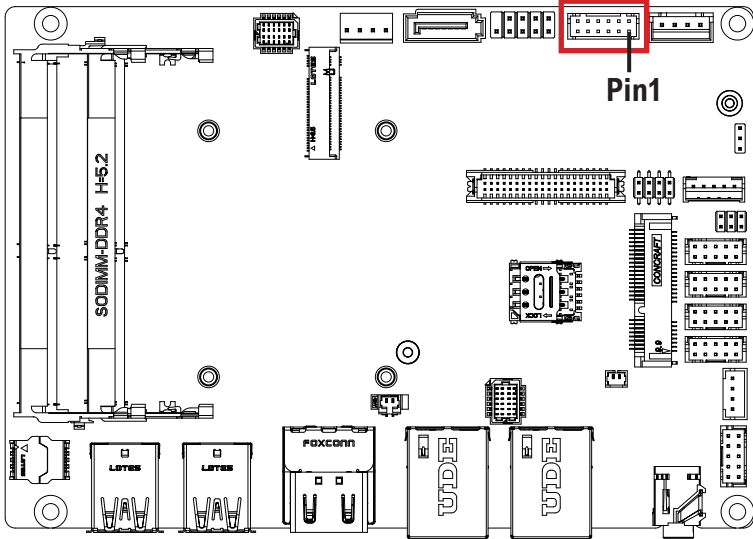


Connector PN	Vendor
210-92-05GB04	PINREX
PH10R53BAZ009	HORNGTONG

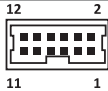
Pin No.	Definition
1	5V
2	5V
3	D2n
4	D1n
5	D2p
6	D1p
7	GND
8	GND
9	No Pin
10	No Connect

2.2.15 GPIO_CNT (General Purpose input/output header)

15



GPIO Connector



Pin No.	Definition
1	GPIO-output_1
2	GPIO-input_1
3	GPIO-output_2
4	GPIO-input_2
5	GPIO-output_3
6	GPIO-input_3
7	GPIO-output_4
8	GPIO-input_4
9	SMBus Clock
10	SMBus DATA
11	5V
12	GND

Connector PN

725-81-12TW00

A2004WV-2X06P46

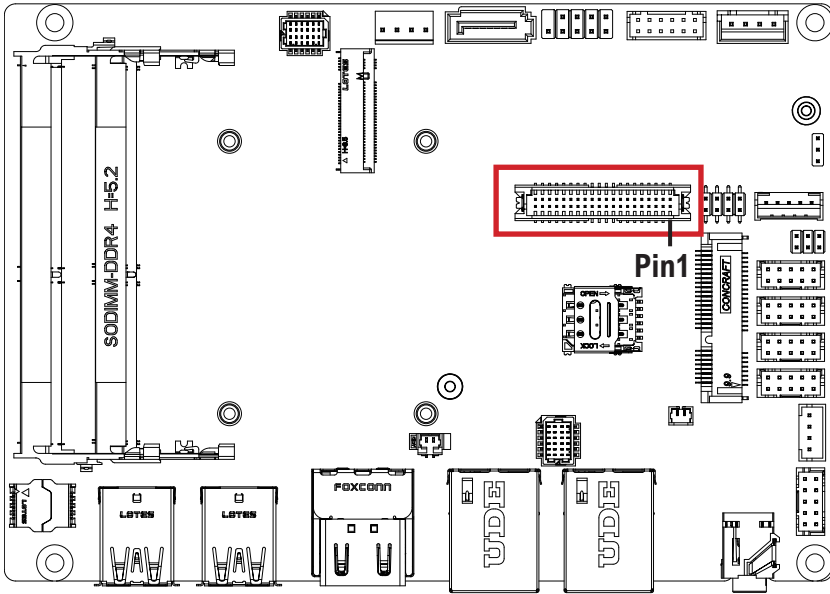
Vendor

PINREX

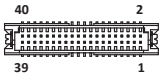
JOINT-TECH

2.2.16 LVDS (LVDS connector)

16



LVDS Connector



Pin No.	Definition	Pin No.	Definition
17	A3-	37	GND
18	A2-	38	GND
19	GND	39	12V
20	GND	40	12V

Pin No.	Definition	Pin No.	Definition
1	3.3V	21	A5+
2	5V	22	A4+
3	3.3V	23	A5-
4	5V	24	A4-
5	SPECO	25	GND
6	SPEDO	26	GND
7	GND	27	A7+
8	GND	28	A6+
9	A1+	29	A7-
10	A0+	30	A6-
11	A1-	31	GND
12	A0-	32	GND
13	GND	33	CLK2+
14	GND	34	CLK1+
15	A3+	35	CLK2-
16	A2+	36	CLK1-

For each model support LVDS function.

But below model no need to add.

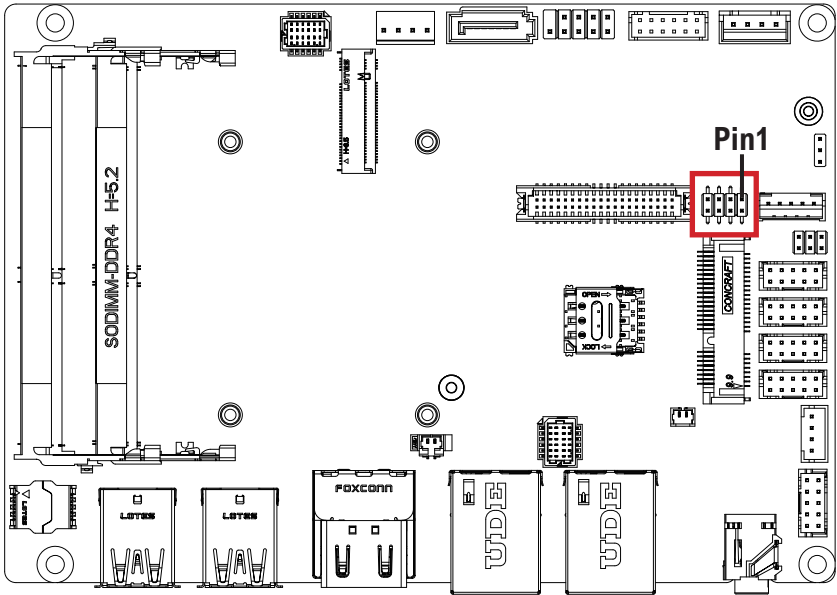
A0~A3 is odd channel 0~3, A4~A7 is even channel.

















Connector PN	Vendor
712-76-40GWEO	PINREX
A1252WV-SF-2X20PD01	JOINT-TECH

Note: *The LVDS output connector of the unit is only intended to be connected to an UL/IEC/EN approval equipment with fire enclosure.

2.2.17 LSW (LVDS resolution jumper)

17

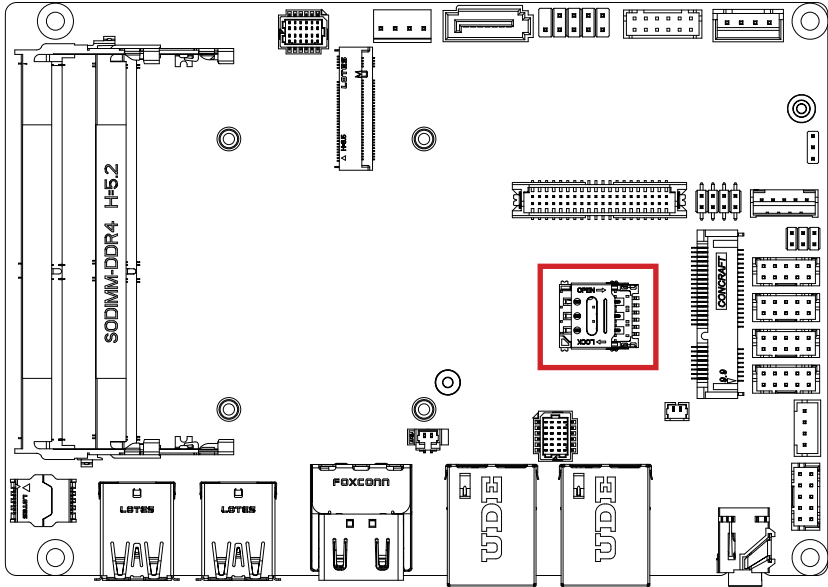


LVDS Resolution Jumper			
Jumper Setting	Resolution	Jumper Setting	Resolution
	800 x 600 18bit (default)		1366 x 768 24bit
	1024 x 768 18bit		1440 x 900 24bit
	1024 x 768 24bit		1400 x 1050 24bit
	1024 x 600 18bit		1600 x 900 24bit
	1280 x 800 18bit		1680 x 1050 24bit
	1280 x 960 18bit		1600 x 1200 24bit
	1280 x 1024 24bit		1920 x 1080 24bit
	1366 x 768 18bit		1920 x 1200 24bit

Connector PN	Vendor
222-97-04GBE1	PINREX

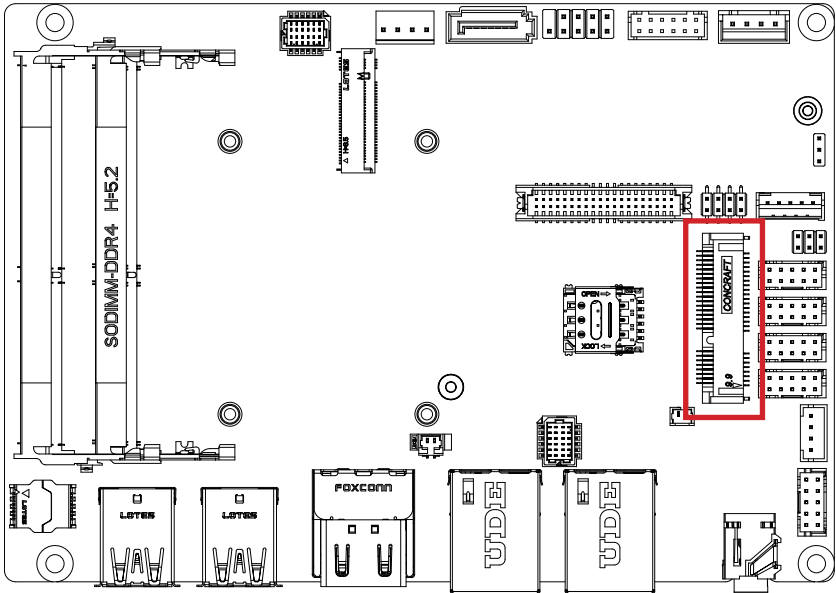
2.2.18 SIM_CARD (3G/4G SIM Slot)

18

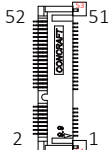


2.2.19 MPCIE (Mini PCIe slot)

19



Mini PCIe Connector



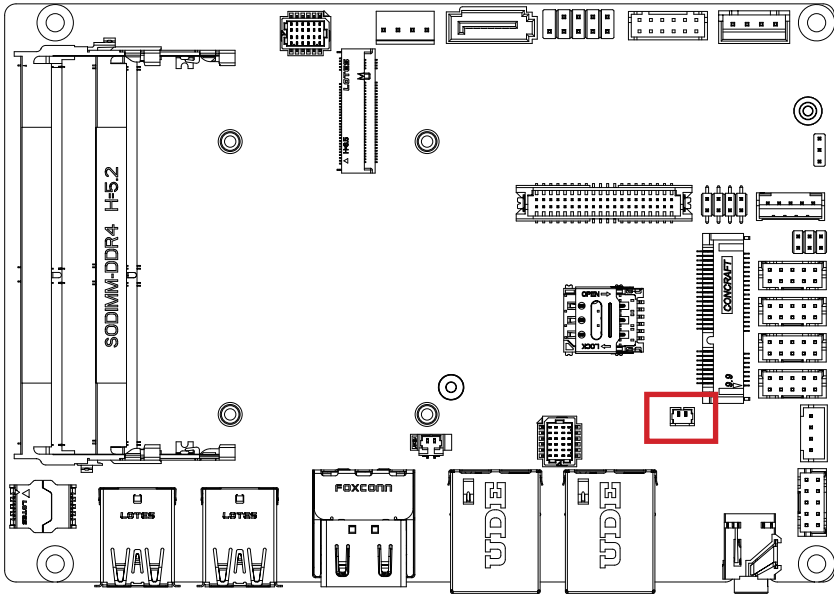
Pin No.	Definition	Pin No.	Definition
1	PCIE WAKE	2	3.3V
3	NC	4	GND
5	NC	6	NC
7	PCIE Clock Request	8	SIM VCC
9	GND	10	SIM DATA
11	PCIE Clock n	12	SIM Clock
13	PCIE Clock p	14	SIM Reset
15	GND	16	reserve
17	NC	18	GND
19	NC	20	WLAN_DISABLE
21	GND	22	Reset
23	PCIE RXn	24	3.3V

Pin No.	Definition	Pin No.	Definition
25	PCIE RXp	26	GND
27	GND	28	NC
29	GND	30	SMB Clock
31	PCIE TXn	32	SMB DATA
33	PCIE TXp	34	GND
35	GND	36	USB Dn
37	GND	38	USB Dp
39	3.3V	40	GND
41	3.3V	42	NC
43	GND	44	NC
45	NC	46	NC
47	NC	48	NC
49	NC	50	GND
51	NC	52	3.3V
53	GND	54	GND

Connector PN	Vendor
AS0B221-S99Q-7H	FOXCONN

2.2.20 BUZZER (Buzzer header)

20



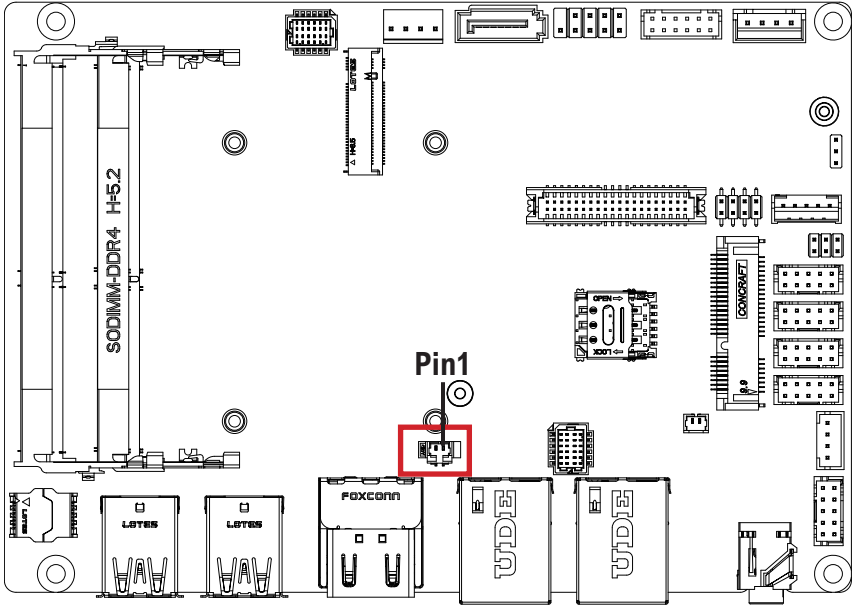
Buzzer header

Connector PN	Vendor
712-71-02TW01	PINREX
A1250WV-02P	JOINT-TECH

Pin No.	Definition
1	Buzzer
2	5V

2.2.21 BATTERY

21



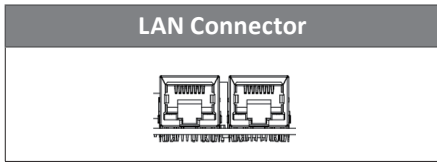
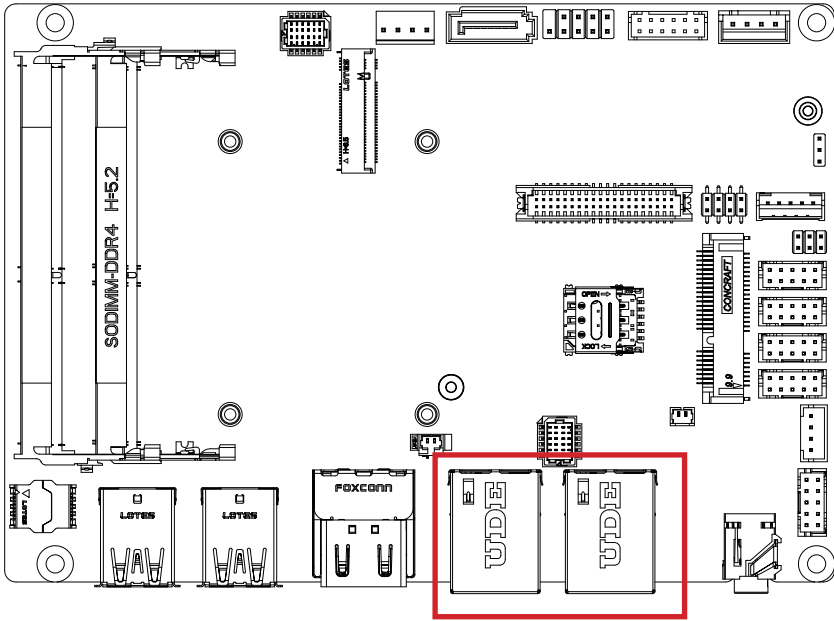
Battery Cable Connector	
2	1

Connector PN	Vendor
85205-0270L	ACES
A1250WV-S-02PC	JOINT-TECH

Pin No.	Definition
1	3V
2	GND

2.2.22 LAN1, LAN2 (LAN connector)

23

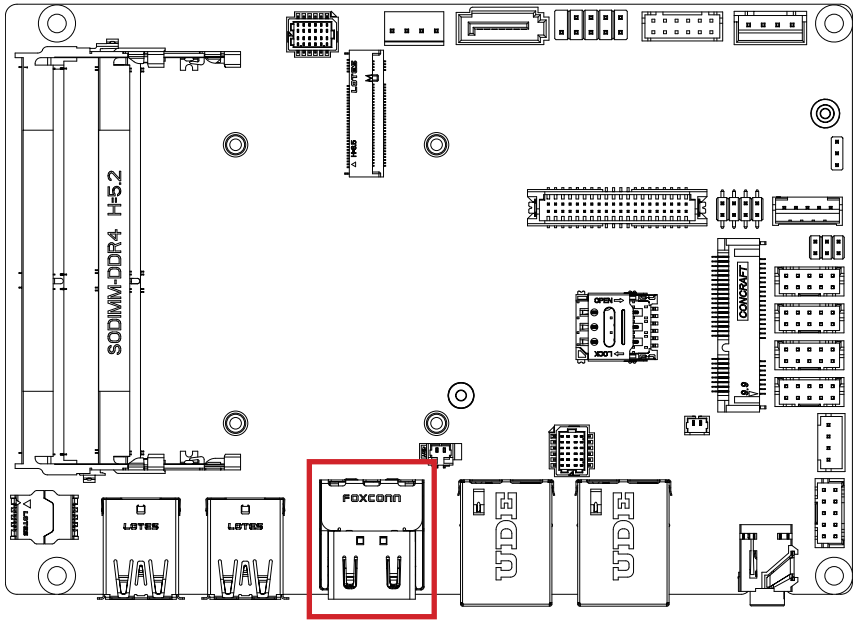


Status	Description
Orange On	1Gbps data rate
Green On	100Mbps data rate
Off	10Mbps data rate

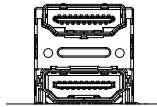
Pin No.	Definition
1	TX1+
2	TX1-
3	TX2+
6	TX2-
4	TX3+
5	TX3-
7	TX4+
8	TX4-

2.2.23 HDMI (HDMI connector)

24



HDMI Connector

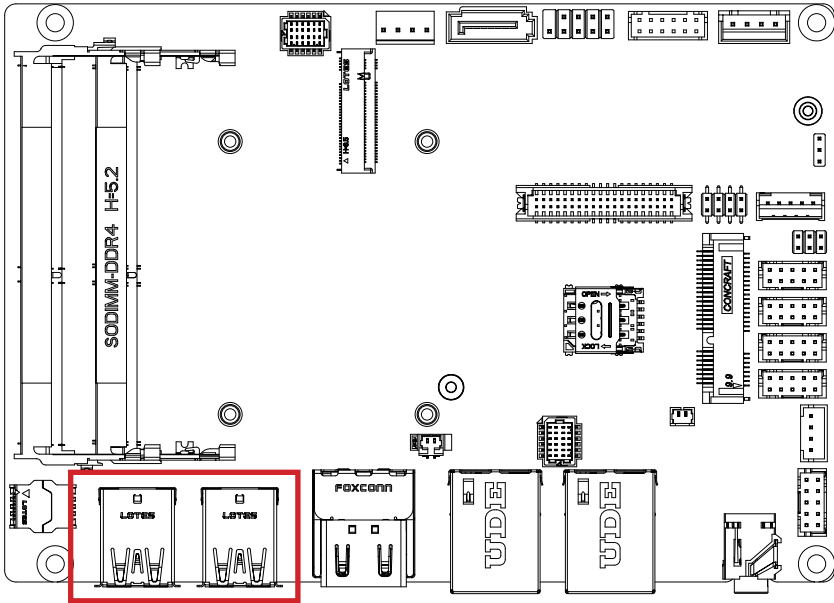


Pin No.	Definition	Pin No.	Definition
1	TX2p	20	TX2p
2	GND	21	GND
3	TX2n	22	TX2n
4	TX1p	23	TX1p
5	GND	24	GND
6	TX1n	25	TX1n
7	TX0p	26	TX0p
8	GND	27	GND
9	TX0n	28	TX0n
10	CLKp	29	CLKp
11	GND	30	GND

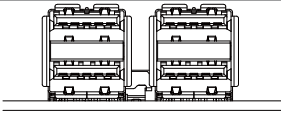
Pin No.	Definition	Pin No.	Definition
12	CLKn	31	CLKn
13	NC	32	NC
14	NA	33	NA
15	DDC Clock	34	DDC Clock
16	DDC Data	35	DDC Data
17	GND	36	GND
18	5V	37	5V
19	Hot Plug Detect	38	Hot Plug Detect

2.2.24 USB31_1, USB31_2 (USB 3.2 Gen 1 connector)

25



USB Connector



Pin No.	Definition
1	5V
2	D1n
3	D1p
4	GND
5	USB3_RX1n
6	USB3_RX1p
7	GND
8	USB3_TX1n
9	USB3_TX1p
10	5V

Pin No.	Definition
11	D0n
12	D0p
13	GND
14	USB3_RX2n
15	USB3_RX2p
16	GND
17	USB3_TX2n
18	USB3_TX2p

Chapter 3

Chapter 3 – BIOS

3.1 Introduction

BIOS (Basic input/output system) provides hardware detailed information and boot-up options, which include firmware to control, set-up and test all hardware settings. Therefore, BIOS is the communication bridge between OS/application software and hardware.

3.1.1 How to Entering into BIOS menu

Once the system is power on, press the key as soon as possible to access into BIOS Setup program.

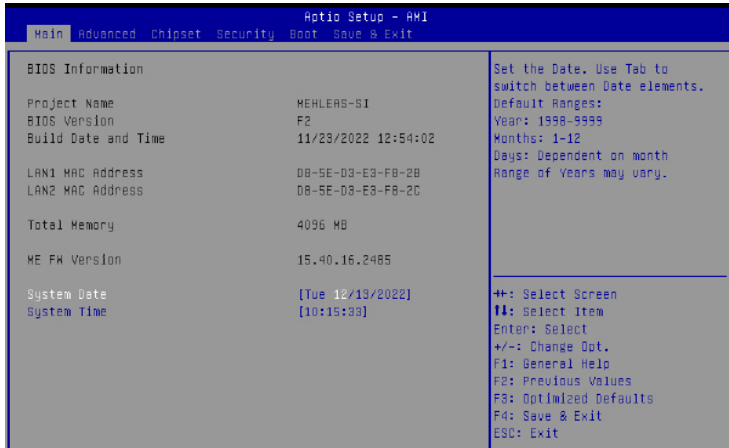
3.1.2 Function Keys to setup in BIOS Setup program

Function keys	Description
→←	Select Screen
↑↓	Select Item
Enter	Execute command or enter the submenu
+	Increase the numeric value or make changes
—	Decrease the numeric value or make changes
F1	General Help
F2	Previous Values
F3	Load Optimized Defaults Settings
F4	Save changes & Exit the BIOS Setup program
ESC	Exit the BIOS Setup program

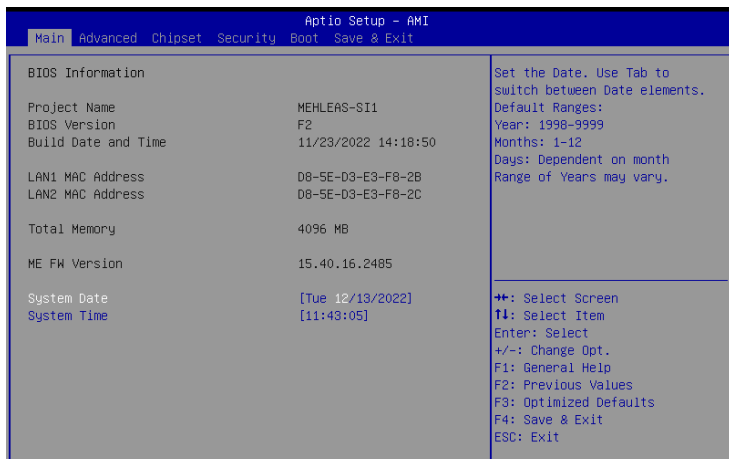
3.2 The Main Menu

The main menu shows the basic system information. Use arrow keys to move among the items.

3.2.1 The Main Menu for QBiP-x6413EA



3.2.2 The Main Menu for QBiP-x6413EAT



Items	Description
Project Name	Shows Project name information
BIOS Version	Shows the BIOS version of the system
Build Date and Time	Shows the Build Date and Time when the BIOS was created.
LAN1 MAC Address	Shows LAN1 MAC Address information
LAN2 MAC Address	Shows LAN2 MAC Address information
Total Memory	Shows the total memory size of the installed memory
ME FW version	Shows ME firmware version
System Date	Set the Date for the system (Format : Week - Month - Day - Year)
System Time	Set the time for the system (Format : Hour - Minute - Second)

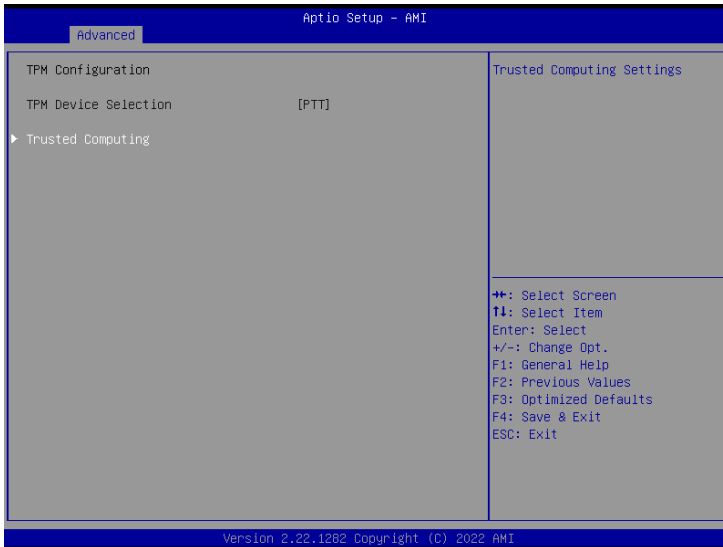
3.3 Advanced

The Advanced menu is to configure the functions of hardware settings through submenu. Use arrow keys to move among the items, and press <Enter> to access into the related submenu.



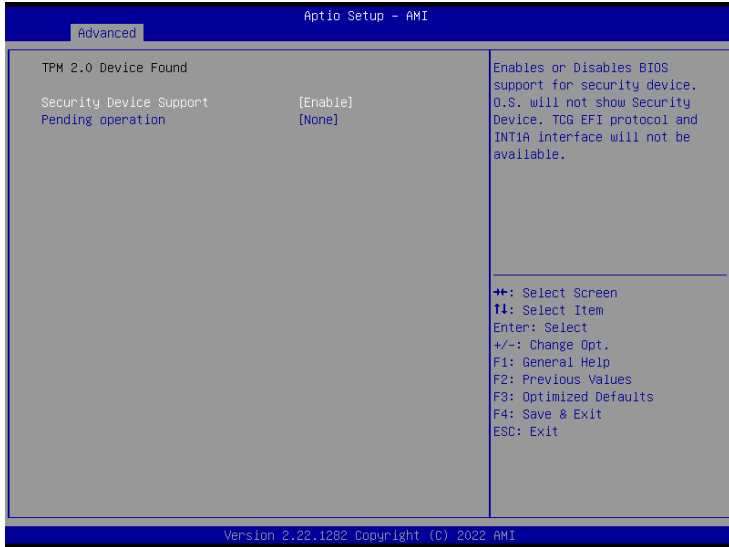
3.3.1 TPM Configuration

Use TPM Configuration submenu to choose TPM interface.



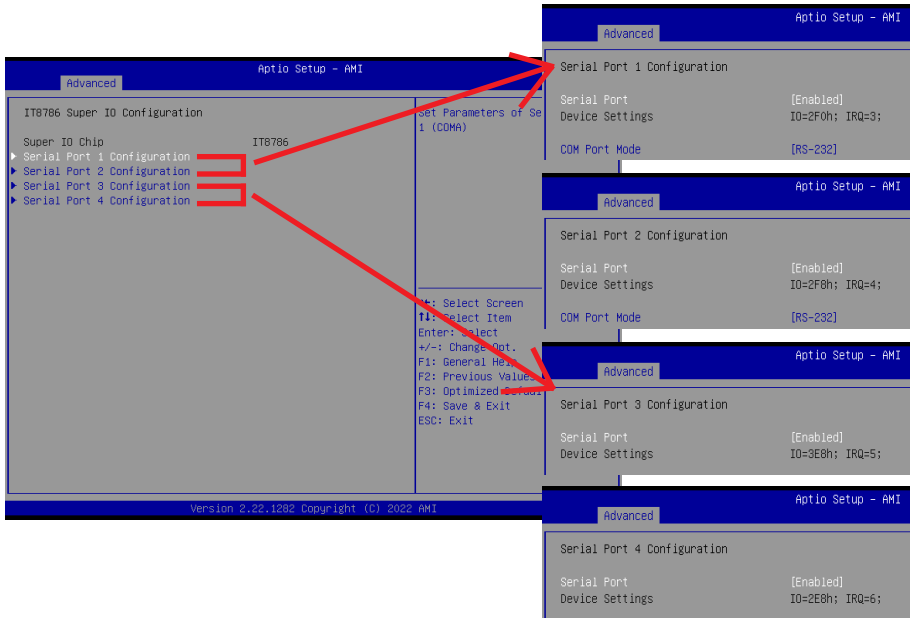
Item	Description
TPM Device Selection	PTT : Internal TPM (Default setting)

Trusted Computing : Shows TPM information, and TPM module configuration setting.



Item	Description
Security Device support	Enabled : Enables TPM feature (Default setting) Disabled : Disables TPM feature
Pending operation	None : No execution will be conducted (Default setting) TPM clear : Set to clear data on TPM

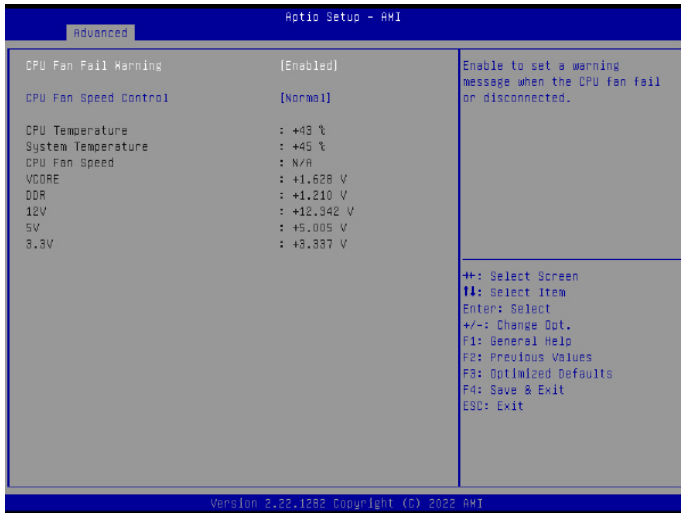
3.3.2 IT8786 Super IO Configuration



Item	Description
Super IO Chip	Shows Super I/O chip model
Serial Port 1 Configuration	Press [Enter] to configure advanced items : Serial Port : Enabled : Enables allows you to configure the serial port settings Disabled : if Disabled, displays no configuration for the serial port
Serial Port 2 Configuration	Device settings : Display the specified Serial Port base I/O address and IRQ COM Port Mode : Choose RS-232, RS-422, or RS-485 feature
Serial Port 3 Configuration	Press [Enter] to configure advanced items : Serial Port : Enabled : Enables allows you to configure the serial port settings Disabled : if Disabled, displays no configuration for the serial port
Serial Port 4 Configuration	Device settings : Display the specified Serial Port base I/O address and IRQ

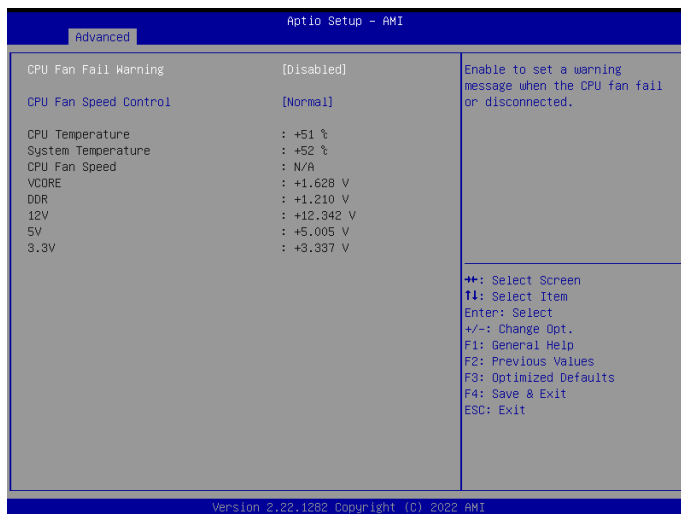
3.3.3 Hardware Monitor

3.3.3.1 Hardware monitor items for QBiP-x6413EA



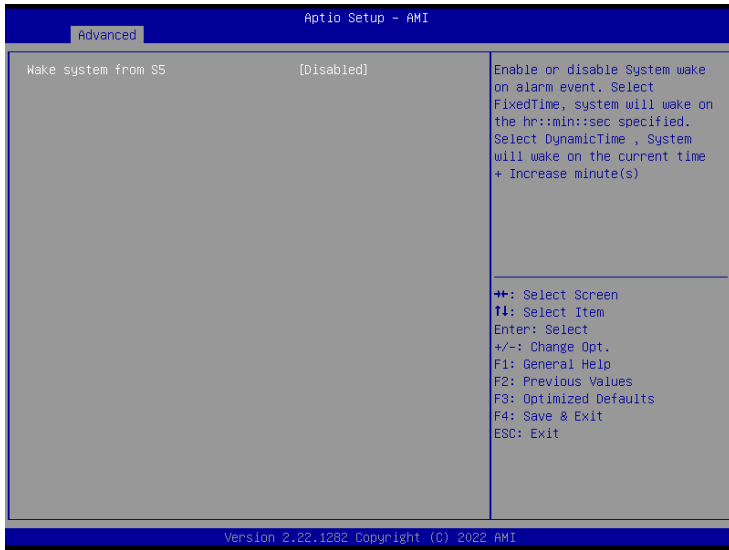
Item	Description
CPU Fan Fail Warning	Enabled : Enables CPU FAN Fail warning alert function (Default setting) Disabled : Disables CPU FAN Fail warning alert function
CPU Fan Speed Control	Normal : Fan speed set by BIOS default (Default setting) Full Speed : Set Fan operates at full speed
CPU temperature	Shows current CPU temperature
System temperature	Shows current system temperature
CPU Fan Speed	Shows current CPU fan Speed

3.3.3.2 Hardware monitor items for QBiP-x6413EAT



Item	Description
CPU Fan Fail Warning	Enabled : Enables CPU FAN Fail warning alert function Disabled : Disables CPU FAN Fail warning alert function (Default setting)
CPU Fan Speed Control	Normal : Fan speed set by BIOS default (Default setting) Full Speed : Set Fan operates at full speed
CPU temperature	Shows current CPU temperature
System temperature	Shows current system temperature
CPU Fan Speed	Shows current CPU fan Speed

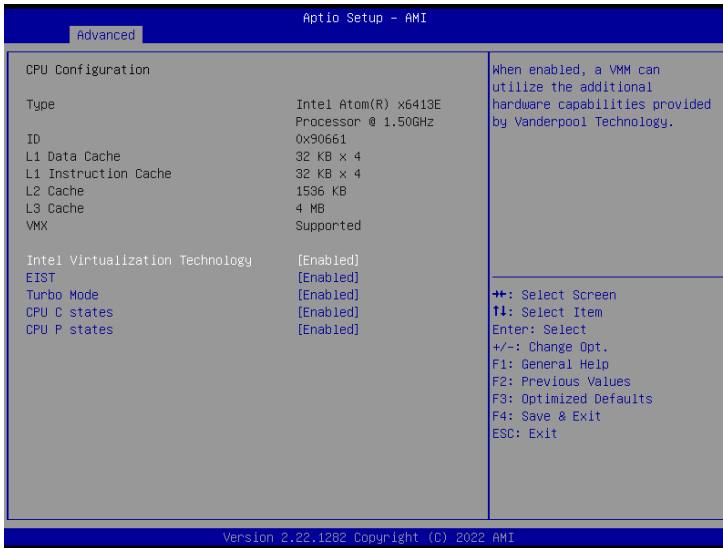
3.3.4 S5 RTC Wake Settings



Item	Description
Wake system from S5	Enable or Disable System to wake on a specific time. Disabled : Disables system to wake on a specific time (Default setting) Fixed Time : Enables system to wake on a specific time (Format : hr : min : sec)

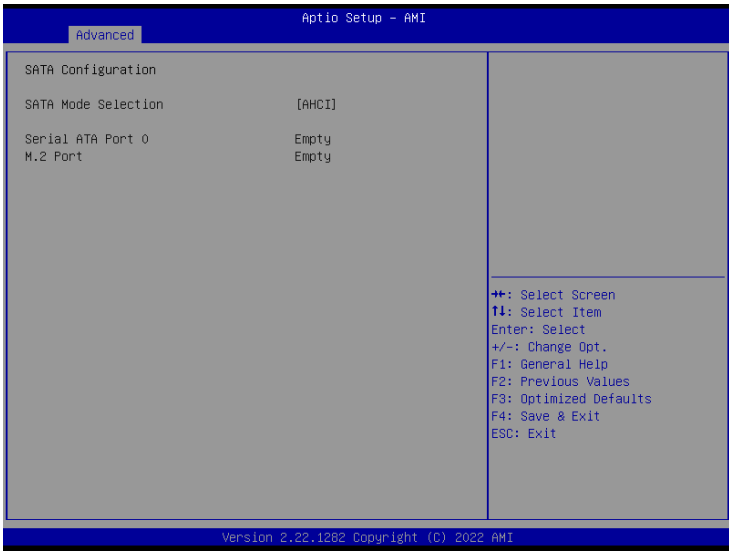
3.3.5 CPU Configuration

This submenu shows detailed CPU informations.



Item	Description
Intel Virtualization Technology	Virtualization enhanced by Intel® Virtualization Technology will allow a platform to run multiple operating systems and applications in independent partitions. With virtualization, one computer system can function as multiple virtual systems. Enabled : Enables Intel Virtualization Technology (Default setting) Disabled : Disables Intel Virtualization Technology
EIST	According to System loading, Enhanced Intel SpeedStep Technology (EIST) will automatically adjust the CPU voltage and core frequency to decrease heat and power consumption for power saving. Enabled : Enables EIST Technology (Default setting) Disabled : Disables EIST Technology
Turbo Mode	Enabled : Enables Turbo Mode (Default setting) Disabled : Disables Turbo Mode
CPU C states	Command CPU to enter into low power consumption mode when CPU is under idle mode. Enabled : Enables C states (Default setting) Disabled : Disables C states
CPU P states	CPU will adjust frequency depends on it's loading. Enabled : Enables CPU P states function (Default setting) Disabled : Disables CPU P states function

3.3.6 SATA Configuration



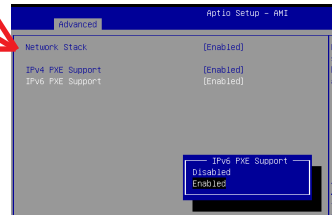
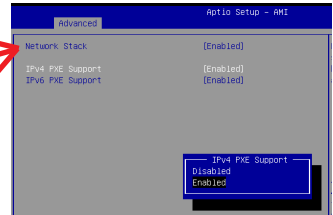
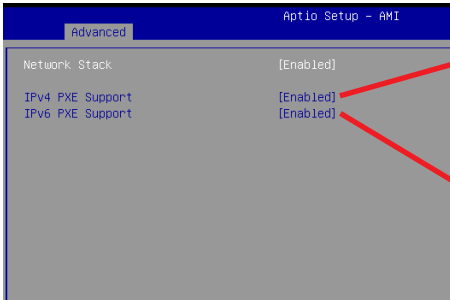
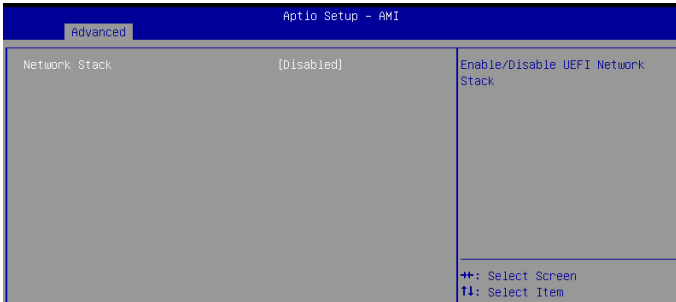
Item	Description
SATA Mode Selection	AHCI : Configures the SATA controllers to AHCI mode. (Default setting)
Serial ATA Port 0	shows 2.5" SATA HDD/SSD information
M.2 Port	shows M.2 SATA interface SSD information

3.3.7 AMI Graphic Output Protocol Policy



Item	Description
Output Select	Choose default monitor output when there are more than one monitor plugged on the motherboard.

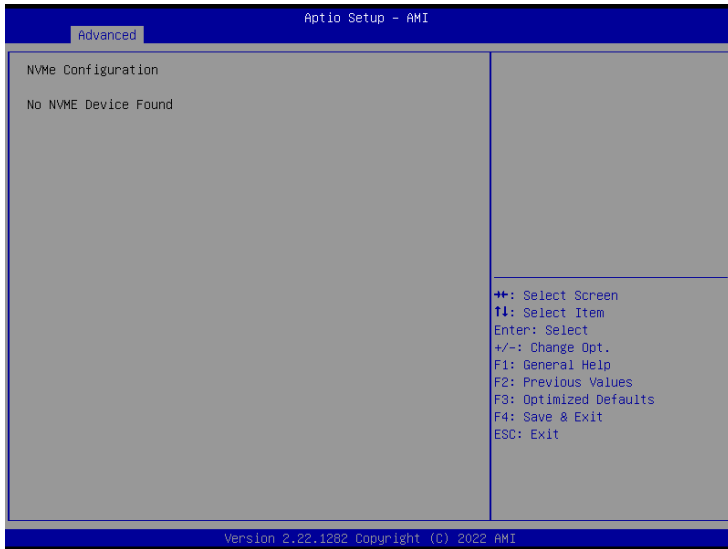
3.3.8 Network Stack Configuration



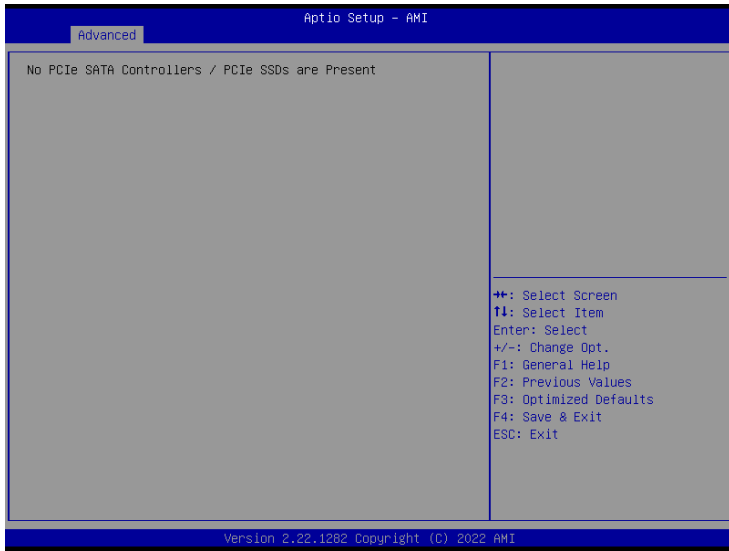
Item	Description
Network Stack	When system is power on, install LAN driver under UEFI mode Disabled : Disables UEFI Network Stack (Default setting) Enabled : Enables UEFI Network Stack
Ipv4 PXE Support	When Network stack is enabled : Disabled : Disables Ipv4 PXE Support Enabled : Enables Ipv4 PXE Support
Ipv6 PXE Support	When Network stack is enabled : Disabled : Disables Ipv6 PXE Support Enabled : Enables Ipv6 PXE Support

3.3.9 NVMe Configuration

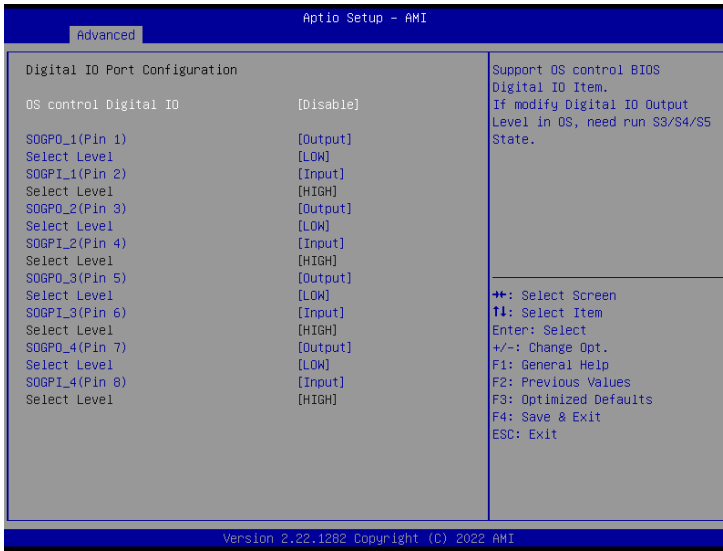
NVMe Configuration shows information when your M.2 NVMe PCIe SSD is installed.



3.3.10 Offboard SATA Controller Configuration

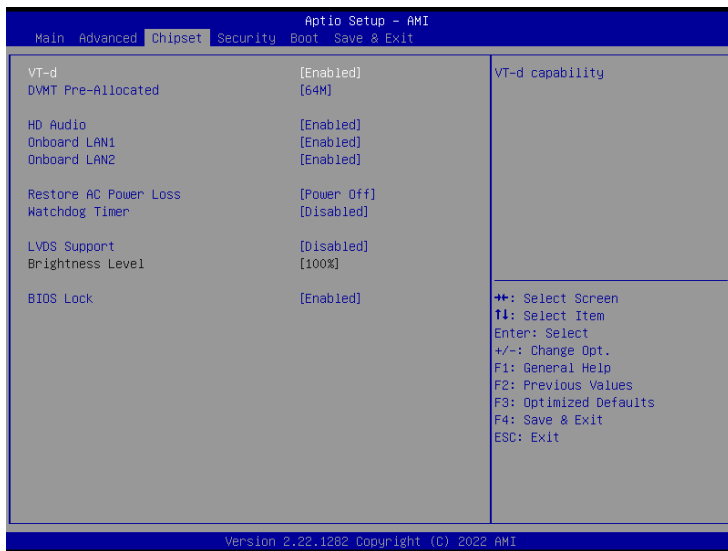


3.3.11 Digital IO Port Configuration



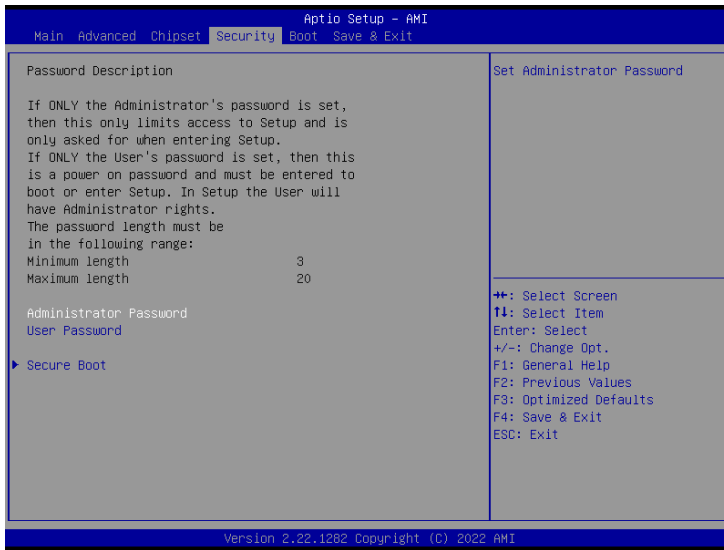
Item	Description
OS control Digital IO	<p>Disabled : If Digital IO Output value/level is modified in OS, they will not be memorized and kept. (Default setting)</p> <p>Enabled : If Digital IO Output value/level is modified in OS, they will be memorized and kept.</p>
<p>SOGPO_1 (Pin 1) SOGPI_1 (Pin 2) SOGPO_2 (Pin 3) SOGPI_2 (Pin 4) SOGPO_3 (Pin 5) SOGPI_3 (Pin 6) SOGPO_4 (Pin 7) SOGPI_4 (Pin 8)</p>	Configure Digital IO Input or Output values for each pin.

3.4 Chipset



Item	Description
VT-d	Enabled : Enables VT-d function (Default setting) Disabled : Disables VT-d function
DVMT Pre-Allocated	Use DVMT Pre-Allocated to set the amount of system memory which is installed to the integrated graphics processor Option items : 32M , 64M(Default setting) , 128M , 256M
HD Audio	Enable/Disable onboard audio controller Enabled : Enables onboard audio controller (Default setting) Disabled : Disables onboard audio controller
Onboard LAN1 Onboard LAN2	Enable/Disable onboard LAN controller Enabled : Enables onboard LAN controller (Default setting) Disabled : Disables onboard LAN controller
Restore AC Power Loss	To set which option the system should returns if a sudden power loss occurred Power off : Do not power on when the power is back (Default setting) Power on : System power on when the power is back Last state : Restore the system to the state before power loss occurs
Watchdog Timer	Enable/Disable Watchdog Timer function Enabled : Enables Watchdog Timer function Disabled : Disabled Watchdog Timer function (Default setting)
LVDS Support	Disabled : Disables LVDS Support (Default setting) Enabled : Enables LVDS Support
Brightness Level	To modified the backlight brightness of the LVDS panel Option items : 10% , 20% , 30% , 40% , 50% , 60% , 70% , 80% , 90% , 100% (Default Setting)
BIOS Lock	Enable/Disable BIOS Lock function Enabled : Enables BIOS Lock function (Default setting) Disabled : Disabled BIOS Lock funtion

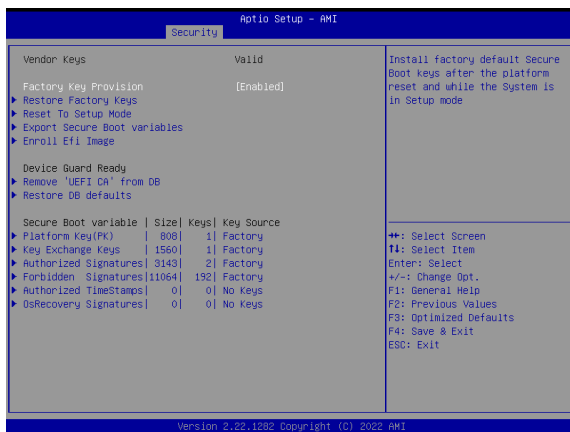
3.5 Security



Item	Description
Administrator Password	To set up Administrator's password Minimum length : 3 Maximum length : 20
User Password	To set up User's password Minimum length : 3 Maximum length : 20
Secure Boot	Press <Enter> to configure the advanced items



Item	Description
Secure Boot	Secure Boot requires all the applications that are running during the booting process to be pre-signed with valid digital certificates Enabled : Enables Secure Boot function Disabled : Disables Secure Boot function (Default setting)
Secure Boot Mode	Standard : Standard mode Custom : Custom mode (Default setting)
Restore Factory Keys	To restore factory settings Yes : Agree to restore factory settings No : Cancel to restore factory settings
Reset To Setup Mode	Yes : Agree to setup mode No : Cancel to setup mode
Key Management	Enables expert users to modify Secure boot policy variables without full authentication Press <Enter> to configure the advanced items

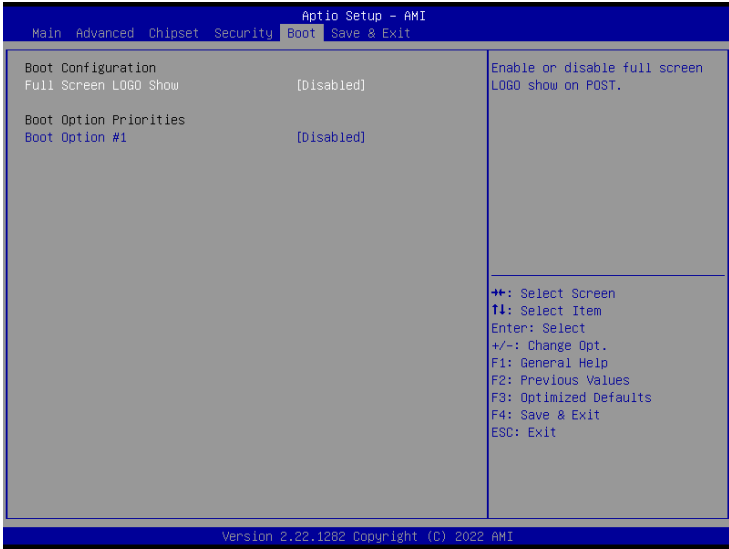


Item	Description
Factory Key Provision	Install factory default Secure Boot keys after the platform reset and while the system is in Setup mode Enabled : Enables Factory Key Provision (Default setting) Disabled : Disables Factory Key Provision
Restore Factory Keys	To restore factory settings Yes : Agree to restore factory settings No : Cancel to restore factory settings
Reset To Setup Mode	Yes : Agree to setup mode No : Cancel to setup mode
Export Secure Boot variables	Copy NVRAM content of Secure Boot variables to files in a root folder on a file system device
Enroll Efi Image	Allow the image to run in Secure Boot mode
Remove 'UEFI CA' from DB	To remove 'UEFI CA' from database Yes : Agree to remove 'UEFI CA' from database No : Cancel to remove 'UEFI CA' from database
Restore DB defaults	Restore DB variables to factory defaults Yes : Agree to restore DB defaults No : Cancel to restore DB defaults

Item	Description
Platform Key (PK)	These items allows you to enroll factory defaults or load Certificates from a file.
Key Exchange Keys	
Authorized Signatures	
Forbidden Signatures	
Authorized TimeStamps	
OsRecovery Signatures	

3.6 Boot

This Boot menu allows you to set/change system boot options



Item	Description
Full Screen LOGO Show	Enable/Disable full screen LOGO show on POST screen Enabled : Enables Full screen LOGO Show on POST screen Disabled : Disables Full screen LOGO Show on POST screen (Default setting)
Boot Option #1 Boot Option #2	Shows the information of the storage that be installed in the system Choose/set the boot priority

3.7 Save & Exit



Item	Description
Save Changes and Reset	After configuring all the options that you wish to change, choose this option to save all the changes and reboot the system Yes : Agree to save and reset No : Cancel to save and reset
Discard Changes and Reset	Choose this option to reboot the system without saving any changes Yes : Agree to discard changes and reset No : Cancel to discard changes and reset
Restore Defaults	Restore/Load default values for all the setup options Yes : Agree to load optimized defaults No : Cancel to load optimized defaults
Me FW Image Re-Flash	Enable/Disable Me FW image re-flash function Enabled : Enables Me FW image re-flash function Disabled : Disables Me FW image re-flash function (Default setting)

Our company network supports you worldwide with offices in Germany, Austria, Switzerland, the UK and the USA. For more information please contact:

Headquarters

Germany



FORTEC Elektronik AG

Augsburger Str. 2b
82110 Germering

Phone: +49 89 894450-0
E-Mail: info@fortecaq.de
Internet: www.fortecaq.de

Fortec Group Members

Austria



Distec GmbH Office Vienna

Nuschinggasse 12
1230 Wien

Phone: +43 1 8673492-0
E-Mail: info@distec.de
Internet: www.distec.de

Germany



Distec GmbH

Augsburger Str. 2b
82110 Germering

Phone: +49 89 894363-0
E-Mail: info@distec.de
Internet: www.distec.de

Switzerland



ALTRAC AG

Bahnhofstraße 3
5436 Würenlos

Phone: +41 44 7446111
E-Mail: info@altrac.ch
Internet: www.altrac.ch

United Kingdom



Display Technology Ltd.

Osprey House, 1 Osprey Court
Hinchingsbrooke Business Park
Huntingdon, Cambridgeshire, PE29 6FN

Phone: +44 1480 411600
E-Mail: info@displaytechnology.co.uk
Internet: www.displaytechnology.co.uk

USA



Apollo Display Technologies, Corp.

87 Raynor Avenue, Unit 1
Ronkonkoma, NY 11779

Phone: +1 631 5804360
E-Mail: info@apolloDisplays.com
Internet: www.apolloDisplays.com